



EF6809

8-BIT MICROPROCESSING UNIT

The EF6809 is a revolutionary high performance 8-bit microprocessor which supports modern programming techniques such as position independence, reentrancy, and modular programming.

This third generation addition to the 6800 Family has major architectural improvements which include additional registers, instructions, and addressing modes.

The basic instructions of any computer are greatly enhanced by the presence of powerful addressing modes. The EF6809 has the most complete set of addressing modes available on any 8 bit microprocessor today.

The EF6809 has hardware and software features which make it an ideal processor for higher level language execution or standard controller applications.

EF6800 COMPATIBLE

- Hardware — Interfaces with All 6800 Peripherals
- Software — Upward Source Code Compatible Instruction Set and Addressing Modes

ARCHITECTURAL FEATURES

- Two 16-Bit Index Registers
- Two 16-Bit Indexable Stack Pointers
- Two 8 Bit Accumulators can be Concatenated to Form One 16-Bit Accumulator
- Direct Page Register Allows Direct Addressing Throughout Memory

HARDWARE FEATURES

- On-Chip Oscillator (Crystal Frequency = $4 \times E$)
- DMA, BREQ Allows DMA Operation on Memory Refresh
- Fast Interrupt Request Input Stacks Only Condition Code Register and Program Counter
- MRDY Input Extends Data Access Times for Use with Slow Memory
- Interrupt Acknowledge Output Allows Vectoring by Devices
- Sync Acknowledge Output Allows for Synchronization to External Event
- Single Bus-Cycle RESET
- Single 5-Volt Supply Operation
- NMI Inhibited After RESET Until After First Load of Stack Pointer
- Early Address Valid Allows Use with Slower Memories
- Early Write Data for Dynamic Memories

SOFTWARE FEATURES

- 10 Addressing Modes
 - 6800 Upward Compatible Addressing Modes
 - Direct Addressing Anywhere in Memory Map
 - Long Relative Branches
 - Program Counter Relative
 - True Indirect Addressing
 - Expanded Indexed Addressing
 - 0-, 5-, 8-, or 16-Bit Constant Offsets
 - 8- or 16-Bit Accumulator Offsets
 - Auto Increment/Decrement by 1 or 2
- Improved Stack Manipulation
- 1464 Instructions with Unique Addressing Modes
- 8×8 Unsigned Multiply
- 16-Bit Arithmetic
- Transfer/Exchange All Registers
- Push/Pull Any Registers or Any Set of Registers
- Load Effective Address

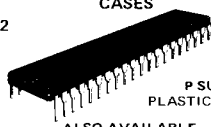
HMOS

(HIGH DENSITY N-CHANNEL, SILICON-GATE)

8-BIT MICROPROCESSING UNIT

CASES

CB-182



P SUFFIX
PLASTIC PACKAGE

J SUFFIX
CERDIP PACKAGE

C SUFFIX
CERAMIC PACKAGE

CB-521



FN SUFFIX
PLCC 44

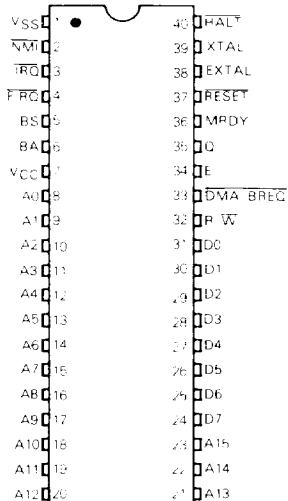
CB-708



E SUFFIX
LCCC 44

Hi-Rel versions available - See chapter 9

PIN ASSIGNMENT



MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Supply Voltage	V_{CC}	$+5.0 \pm 5\%$	V
Input Voltage	V_{IH}	$+0.5$ to $+5.5$	V
Operating Temperature	T_A	-55 to $+125$	$^{\circ}\text{C}$
EF6809, EF68A09, EF68B09 EF6809, EF68A09, EF68B09 - V suffix EF6809, EF68A09 - M suffix		-55 to $+125$	$^{\circ}\text{C}$
Storage Temperature Range	T_{STG}	-65 to $+150$	$^{\circ}\text{C}$

THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance Junction to Ambient Junction to Case Package	θ_{JA}	50 60 100	$^{\circ}\text{C/W}$

POWER CONSIDERATIONS

The average chip junction temperature, $T_{J(AV)}$, in $^{\circ}\text{C}$ can be obtained from:

$$T_{J(AV)} = T_A + (P_D + P_{PQRT}) \cdot \theta_{JA}$$

Where:

T_A = Ambient Temperature, $^{\circ}\text{C}$

θ_{JA} = Package Thermal Resistance, Junction to Ambient, $^{\circ}\text{C/W}$

P_D = $P_{INT} + P_{PQRT}$

P_{INT} = $I_{CC} \times V_{CC}$, Watts = Chip Internal Power

P_{PQRT} = Port Power Dissipation, Watts = User Determined

For most applications $P_{PQRT} \ll P_{INT}$ and can be neglected. P_{PQRT} may become significant if the device is configured to drive Darlington bases or sink LED loads.

An approximate relationship between P_D and $T_{J(AV)}$ (if P_{PQRT} is neglected) is:

$$P_D = K \cdot (T_{J(AV)} + 273^{\circ}\text{C})$$

(1)

Solving equations 1 and 2 for K gives:

$$K = P_D / (T_A + 273^{\circ}\text{C}) - \theta_{JA} \cdot P_D^2$$

(3)

Where K is a constant pertaining to the particular part. K can be determined from equation 3 by measuring P_D (at equilibrium) for a known T_A . Using this value of K the values of P_D and $T_{J(AV)}$ can be obtained by solving equations (1) and (2) iteratively for any value of T_A .

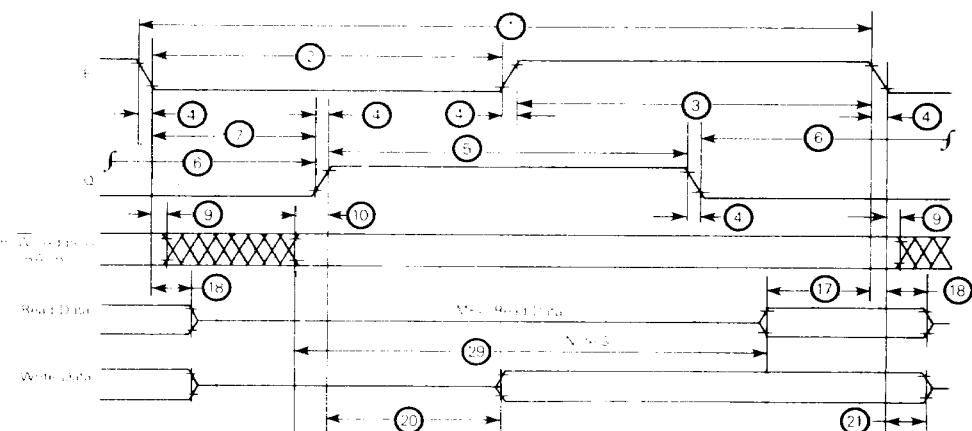
ELECTRICAL CHARACTERISTICS ($V_{CC} = 5.0 \text{ V} \pm 5\%$, $V_{SS} = 0$, $T_A = T_L$ to T_H unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
Input High Voltage Logic: EXTAT, RESET	V_{IH} V_{IHR}	$V_{SS} + 2.0$ $V_{SS} + 4.0$	—	V_{CC} V_{CC}	V
Input Low Voltage Logic: EXTAL, RESET	V_{IL}	$V_{SS} - 0.3$	—	$V_{SS} + 0.8$	V
Input Leakage Current ($V_{IH} = 0$ to 5.25 V , $V_{CC} = \text{max}$)	I_{in}	—	—	25	μA
dc Output High Voltage ($I_{Load} = -205 \mu\text{A}$, $V_{CC} = \text{max}$) ($I_{Load} = -145 \mu\text{A}$, $V_{CC} = \text{min}$) ($I_{Load} = -100 \mu\text{A}$, $V_{CC} = \text{min}$)	V_{OH}	$V_{SS} + 2.4$ $V_{SS} + 2.4$ $V_{SS} + 2.4$	—	—	V
dc Output Low Voltage ($I_{Load} = 2.0 \text{ mA}$, $V_{CC} = \text{min}$)	V_{OL}	—	—	$V_{SS} + 0.5$	V
Internal Power Dissipation (Measured at $T_A = 0^{\circ}\text{C}$ in Steady State Operation)	P_{INT}	—	—	1.0	W
Capacitance* ($V_{IH} = 0$, $T_A = 25^{\circ}\text{C}$, $f = 1.0 \text{ MHz}$)	C_{in}	—	10 10	15 15	pF
Logic Inputs: EXTAL, XTAL A0 A15, R/W, BA, BS	C_{out}	—	—	15	pF
Frequency of Operation (Crystal or External Input)	f_{XTAL}	0.4 0.4 0.4	—	4 6 8	MHz
Hi-Z (Off State) Input Current ($V_{IH} = 0.4$ to 2.4 V , $V_{CC} = \text{max}$)	I_{SI}	—	20 —	10 100	μA

* Capacitances are periodically tested rather than 100% tested

The device contains a built-in protection circuit against damage due to static charges. Electrostatic discharge (ESD) protection is provided that limits the maximum voltage to avoid application of any voltage higher than maximum rated voltages to this high impedance circuit. Regardless of the enhanced ESD protection, inputs are tied to an appropriate logic voltage level (e.g., either VSS or VCC).

FIGURE 1 — BUS TIMING



BUS TIMING CHARACTERISTICS (see Note 1 and 2)

Ident. Number	Characteristics	Symbol	EF6809		EF68A09		EF68B09		Unit
			Min	Max	Min	Max	Min	Max	
1	Access Time (See Note 1)	t _{ACC}	10	10	0.667	10	0.5	10	ns
2	Pulse Width (Low)	t _{PWL}	430	5000	280	5000	210	5000	ns
3	Pulse Width (High)	t _{PWLH}	450	15500	280	15700	220	15700	ns
4	Clock Rise and Fall Time	t _{CRF}		25		25		20	ns
5	Pulse Width (High)	t _{PWH}	430	5000	280	5000	210	5000	ns
6	Pulse Width (Low)	t _{PWL}	450	15500	280	15700	220	15700	ns
7	Delay Time (Setup Bus)	t _{DVS}	200	250	130	165	80	125	ns
8	Address Hold Time (See Note 4)	t _{AH}		20		20			ns
9	t _{BS} , t _B , t _W and Address Valid Time (See Note 3)	t _{AV}	50		25		15		ns
10	Read Data Setup Time	t _{DSR}	80		60		40		ns
11	Read Data Hold Time	t _{DHR}	10		10		10		ns
12	Data Delay Time (Low)	t _{DDQ}		200		140		110	ns
13	Write Data Hold Time	t _{DHW}	30		30		30		ns
14	Output Access Time (See Note 3)	t _{ACC}	660		440		330		ns
15	Processor Control Setup Times (MRDY, Interrupts, DMA, BREQ, WAIT, RESET) (Equation 6, 7, 8, 9, 10, 11, and 12)	t _{PCS}	20		140		110		ns
	Crystal Oscillator Start Time (Equation 1)	t _{AC}		100		100		100	ms
	Processor control Rise and Fall Time (Equation 6 and 11)	t _{QD} , t _{PQ}		100		100		100	ns

* Address and Data hold times are performed only when data is not being updated.

NOTES

1. Voltage levels shown are V_I ≤ 0.4 V, V_{OH} ≥ 2.4 V, unless otherwise specified.
2. Measurement points shown are 0.6 V and 2.0 V, unless otherwise specified.
3. Usable access time is computed by $t_{AV} = t_{max} + 10 \cdot t_{CRF}$.
4. Hold time t_{AV} for BA and BS is not specified.
5. Maximum t_{AV} during MRDY or DMA_BREQ is 16 μs.

FIGURE 2 — EF6809 EXPANDED BLOCK DIAGRAM

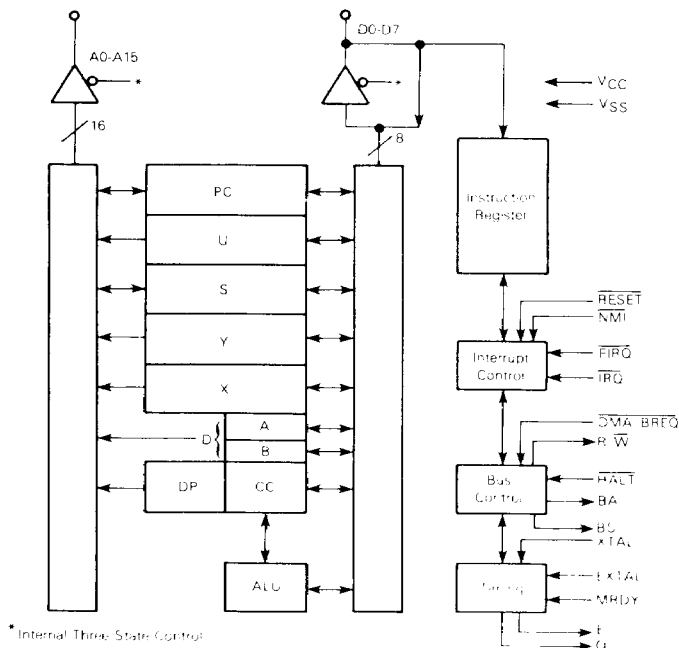
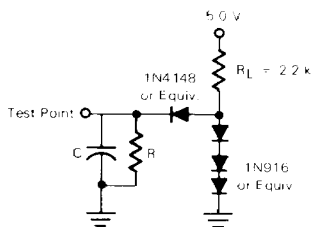


FIGURE 3 — BUS TIMING TEST LOAD



C = 30 pF for BA, BS
130 pF for D0-D7, E, Q
90 pF for A0-A15, R/W

R = 11.7 kΩ for D0-D7
16.5 kΩ for A0-A15, E, Q, R/W
24 kΩ for BA, BS

PROGRAMMING MODEL

As shown in Figure 4, the EF6809 adds three registers to the set available in the EF6800. The added registers include a direct page register, the user stack pointer, and a second index register.

ACCUMULATORS (A, B, D)

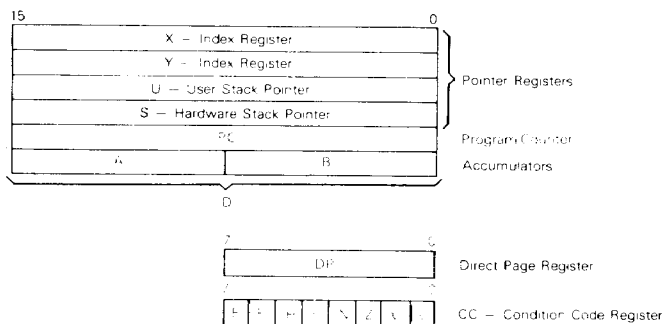
The A and B registers are general purpose accumulators which are used for arithmetic calculations and manipulation of data.

Certain instructions concatenate the A and B registers to form a single 16-bit accumulator. This is referred to as the D register, and is formed with the A register as the most significant byte.

DIRECT PAGE REGISTER (DP)

The direct page register of the EF6809 serves to enhance the direct addressing mode. The content of this register appears at the higher address outputs (A8-A15) during direct addressing instruction execution. This allows the direct mode to be used at any place in memory, under program control. To ensure 6800 compatibility, all bits of this register are cleared during processor reset.

FIGURE 4 — PROGRAMMING MODEL OF THE MICROPROCESSING UNIT



INDEX REGISTERS (X, Y)

The index registers are used in indexed mode of addressing. The 16 bit address in this register takes part in the calculation of effective addresses. This address may be used to point to data directly or may be modified by an optional constant or register offset. During some indexed modes, the contents of the index register are incremented or decremented to point to the next item of tabular type data. All four pointer registers (X, Y, U, S) may be used as index registers.

STACK POINTER (U,S)

The hardware stack pointer (S) is used automatically by the processor during subroutine calls and interrupts. The stack pointers of the EF6809 point to the top of the stack, in contrast to the EF6800 stack pointer, which pointed to the next free location on the stack. The user stack pointer (U) is controlled exclusively by the programmer. This allows arguments to be passed to and from subroutines with ease. Both stack pointers have the same indexed mode addressing capabilities as the X and Y registers, but also support **Push** and **Pull** instructions. This allows the EF6809 to be used efficiently as a stack processor, greatly enhancing its ability to support higher level languages and modular programming.

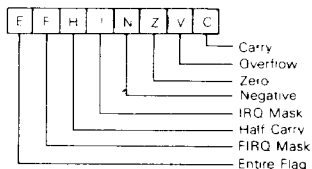
PROGRAM COUNTER

The program counter is used by the processor to point to the address of the next instruction to be executed by the processor. Relative addressing is provided allowing the program counter to be used like an index register in some situations.

CONDITION CODE REGISTER

The condition code register defines the state of the processor at any given time. See Figure 5.

FIGURE 5 — CONDITION CODE REGISTER FORMAT



CONDITION CODE REGISTER DESCRIPTION

BIT 0 (C)

Bit 0 is the carry flag, and is usually the carry from the binary ALU. C is also used to represent a 'borrow' from subtract-like instructions (CMP, NEG, SUB, SBC) and is the complement of the carry from the binary ALU.

BIT 1 (V)

Bit 1 is the overflow flag, and is set to a one by an operation which causes a signed two's complement arithmetic overflow. This overflow is detected in an operation in which the carry from the MSB in the ALU does not match the carry from the MSB 1.

BIT 2 (Z)

Bit 2 is the zero flag, and is set to a one if the result of the previous operation was identically zero.

BIT 3 (N)

Bit 3 is the negative flag, which contains exactly the value of the MSB of the result of the preceding operation. Thus, a negative two's-complement result will leave N set to a one.

BIT 4 (I)

Bit 4 is the $\overline{\text{IRQ}}$ mask bit. The processor will not recognize interrupts from the $\overline{\text{IRQ}}$ line if this bit is set to a one. NMI, $\overline{\text{FIRQ}}$, $\overline{\text{IRQ}}$, RESET, and SWI all set I to a one. SWI2 and SWI3 do not affect I.

BIT 5 (H)

Bit 5 is the half-carry bit, and is used to indicate a carry from bit 3 in the ALU as a result of an 8 bit addition only (ADC or ADD). This bit is used by the DAA instruction to perform a BCD decimal add adjust operation. The state of this flag is undefined in all subtract-like instructions.

BIT 6 (F)

Bit 6 is the $\overline{\text{FIRQ}}$ mask bit. The processor will not recognize interrupts from the $\overline{\text{FIRQ}}$ line if this bit is a one. NMI, $\overline{\text{FIRQ}}$, SWI1, and RESET all set F to a one. $\overline{\text{IRQ}}$, SWI2, and SWI3 do not affect F.

BIT 7 (E)

Bit 7 is the entire flag, and when set to a one indicates that the complete machine state (all the registers) was stacked, as opposed to the subset state (PC and CC). The E bit of the stacked CC is used on a return from interrupt (RTI) to determine the extent of the unstacking. Therefore, the current E left in the condition code register represents past action.

PIN DESCRIPTIONS**POWER (VSS, VCC)**

Two pins are used to supply power to the part: VSS is ground or 0 volts, while VCC is +5.0 V $\pm 5\%$.

ADDRESS BUS (A0-A15)

Sixteen pins are used to output address information from the MPU onto the address bus. When the processor does not require the bus for a data transfer, it will output address FFFF₁₆, $\text{R}/\overline{\text{W}} = 1$, and BS = 0; this is a "dummy access" or VMA cycle. Addresses are valid on the rising edge of Q. All address bus drivers are made high impedance when output bus available (BA) is high. Each pin will drive one Schottky TTL load or four LSTTL loads, and 90 pF.

DATA BUS (D0-D7)

These eight pins provide communication with the system bidirectional data bus. Each pin will drive one Schottky TTL load or four LSTTL loads, and 130 pF.

READ/WRITE (R/ $\overline{\text{W}}$)

This signal indicates the direction of data transfer on the data bus. A low indicates that the MPU is writing data onto the data bus. R/ $\overline{\text{W}}$ is made high impedance when BA is high. R/ $\overline{\text{W}}$ is valid on the rising edge of Q.

RESET

A low level on this Schmitt trigger input for greater than one bus cycle will reset the MPU, as shown in Figure 6. The reset vectors are latched from locations FFFF₁₆ and FFFF₁₆ (Table 1) when interrupt acknowledge is true, ($\text{BA} \bullet \text{BS} = 1$). During initial power on, the RESET line should be held low until the clock oscillator is fully operational. See Figure 7.

Because the EF6809 RESET pin has a Schmitt-trigger input with a threshold voltage higher than that of standard peripherals, a simple R/C network may be used to reset the entire system. This higher threshold voltage ensures that all peripherals are out of the reset state before the processor.

HALT

A low level on this input pin will cause the MPU to stop running at the end of the present instruction and remain halted indefinitely without loss of data. When halted, the BA output is driven high indicating the buses are high impedance. BS is also high which indicates the processor is in the halt or bus grant state. While halted, the MPU will not respond to external real time requests ($\overline{\text{FIRQ}}$, $\overline{\text{IRQ}}$, although DMA/BRQ will always be accepted, and NMI or RESET will be latched for later response. During the halt state, Q and E continue to run normally. If the MPU is not running (RESET, DMA/BRQ), a halted state ($\text{BA} \bullet \text{BS} = 1$) can be achieved by pulling HALT low while RESET is still low. If DMA/BRQ and HALT are both pulled low, the processor will reach the last cycle of the instruction (by reverse cycle stealing) where the machine will then become halted. See Figure 8.

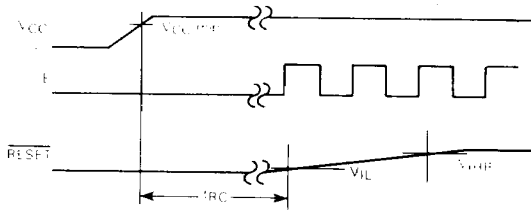
BUS AVAILABLE, BUS STATUS (BA, BS)

The bus available output is an indication of an external control signal which makes the MOS buses of the MPU high impedance. This signal does not imply that the bus will be available for more than one cycle. When BA goes low, a dead cycle will elapse before the MPU acquires the bus.

The bus status output signal, when decoded with BA, represents the MPU state (valid with leading edge of Q).

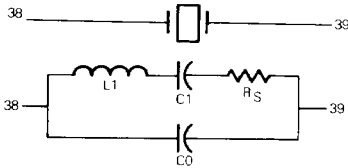
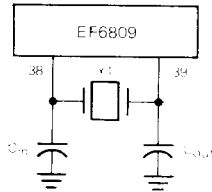
MPU State		MPU State Definition
BA	BS	
0	0	Normal (Running)
0	1	Interrupt or Reset Acknowledge
1	0	Sync Acknowledge
1	1	Halt or Bus Grant Acknowledge

FIGURE 7 — CRYSTAL CONNECTIONS AND OSCILLATOR START UP



NOTE: Waveform measurements for all inputs and outputs are specified at logic high 2.0 V and logic low 0.8 V unless otherwise specified

Y1	C _{in}	C _{out}
8 MHz	18 pF	18 pF
6 MHz	20 pF	20 pF
4 MHz	24 pF	24 pF



Nominal Crystal Parameters				
	3.58 MHz	4.00 MHz	6.0 MHz	8.0 MHz
R _S	60 Ω	50 Ω	30-50 Ω	20-40 Ω
C ₀	3.5 pF	6.5 pF	4-6 pF	4-6 pF
C ₁	0.015 pF	0.025 pF	0.01-0.02 pF	0.01-0.02 pF
Q	> 40 k	> 30 k	> 20 k	> 20 k

All parameters are 10%

NOTE: These are representative AT-cut crystal parameters only. Crystals of other types of cut may also be used

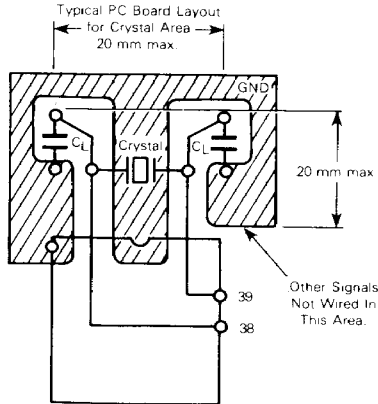
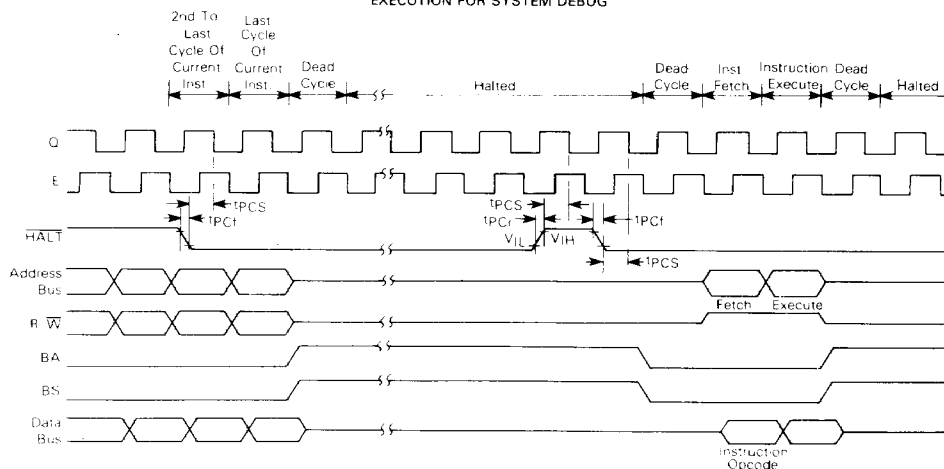


FIGURE 8 — HALT AND SINGLE INSTRUCTION EXECUTION FOR SYSTEM DEBUG



NOTE: Waveform measurements for all inputs and outputs are specified at logic high 2.0 V and logic low 0.8 V unless otherwise specified.

INTERRUPT ACKNOWLEDGE is indicated during both cycles of a hardware vector fetch (RESET, NMI, $\overline{\text{FIRQ}}$, $\overline{\text{IRQ}}$, SW1, SW2, SW3). This signal, plus decoding of the lower four address lines, can provide the user with an indication of which interrupt level is being serviced and a low vectoring by device. See Table 1.

SYNC ACKNOWLEDGE is indicated when the MPV is waiting for external synchronization on an interrupt line.

HALT/BUS GRANT is true when the MCR809 is in a halt or bus grant condition.

TABLE 1 — MEMORY MAP FOR INTERRUPT VECTORS

Memory Map For Vector Locations		Interrupt Vector Description
MS	LS	
FFFE	FFFF	RESET
FFFC	FFFD	NMI
FFFA	FFFB	SW1
FFF8	FFF9	$\overline{\text{IRQ}}$
FFF6	FFF7	$\overline{\text{FIRQ}}$
FFF4	FFF5	SW2
FFF2	FFF3	SW3
FFF0	FFF1	Reserved

NON MASKABLE INTERRUPT (NMI)*

A negative transition on this input requests that a non-maskable interrupt sequence be generated. A non-maskable

interrupt cannot be inhibited by the program, and also has a higher priority than $\overline{\text{FIRQ}}$, $\overline{\text{IRQ}}$, or software interrupts. During recognition of an NMI, the entire machine state is saved on the hardware stack. After reset, an NMI will not be recognized until the first program load of the hardware stack pointer (SP). The pulse width of NMI low must be at least one E cycle. If the NMI input does not meet the minimum set up with respect to Q, the interrupt will not be recognized until the next cycle. See Figure 9.

FAST-INTERRUPT REQUEST ($\overline{\text{FIRQ}}$)*

A low level on this input pin will initiate a fast interrupt sequence, provided its mask bit (F1 in the CC) is clear. This sequence has priority over the standard interrupt request ($\overline{\text{IRQ}}$), and is fast in the sense that it stacks only the contents of the condition code register and the program counter. The interrupt service routine should clear the source of the interrupt before doing an RTI. See Figure 10.

INTERRUPT REQUEST ($\overline{\text{IRQ}}$)*

A low level input on this pin will initiate an interrupt request sequence provided the mask bit (I1 in the CC) is clear. Since $\overline{\text{IRQ}}$ stacks the entire machine state, it provides a slower response to interrupts than $\overline{\text{FIRQ}}$. $\overline{\text{IRQ}}$ also has a lower priority than $\overline{\text{FIRQ}}$. Again, the interrupt service routine should clear the source of the interrupt before doing an RTI. See Figure 9.

*NMI, $\overline{\text{FIRQ}}$, and $\overline{\text{IRQ}}$ requests are sampled on the falling edge of Q. One cycle is required for synchronization before these interrupts are recognized. The pending interrupt will not be serviced until completion of the current instruction unless a SYNC or CWA1 condition is present. If $\overline{\text{IRQ}}$ and $\overline{\text{FIRQ}}$ do not remain low until completion of the current instruction, they may not be recognized. However, NMI is latched and need only remain low for one cycle. No interrupts are recognized until at least two rising edges of BS indicating RESET acknowledge.

XTAL, EXTAL

These inputs are used to connect the on-chip oscillator to an external parallel resonant crystal. Alternately, the pin EXTAL may be used as a TTL level input for external timing by grounding XTAL. The crystal or external frequency is four times the bus frequency. See Figure 7. Proper RF layout techniques should be observed in the layout of printed circuit boards.

E, Q

E is similar to the EF6800 bus timing signal phase 2. Q is a quadrature clock signal which leads E. Q has no parallel on the EF6800. Addresses from the MPU will be valid with the leading edge of Q. Data is latched on the falling edge of E. Timing for E and Q is shown in Figure 11.

MRDY*

This input control signal allows stretching of E and Q to extend data access time. E and Q operate normally while MRDY is high. When MRDY is low, F and Q may be stretched in integral multiples of quarter (1/4) bus cycles, thus allowing interface to slow memories, as shown in Figure 12(a). During non-valid memory access (DMA cycles), MRDY has no effect on stretching F and Q; this inhibits slowing the processor during "don't care" bus accesses. MRDY may also be

used to stretch clocks (for slow memory) when bus control has been transferred to an external device (through the use of HALT and DMA-BREQ).

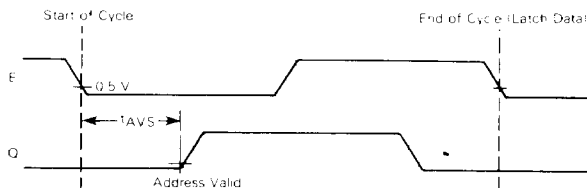
DMA-BREQ*

The DMA-BREQ input provides a method of suspending execution and acquiring the MPU bus for another use, as shown in Figure 13. Typical uses include DMA and dynamic memory refresh.

A low level on this pin will stop instruction execution at the end of the current cycle unless pre-empted by self-refresh. The MPU will acknowledge DMA-BREQ by setting BA and BS to a one. The requesting device will now have up to 15 bus cycles before the MPU retrieves the bus for self-refresh. Self-refresh requires one bus cycle with a leading and trailing dead cycle. See Figure 14. The self-refresh counter is only cleared if DMA-BREQ is inactive for two or more MPU cycles.

Typically, the DMA controller will request to use the bus by asserting DMA-BREQ pin low on the leading edge of E. When the MPU replies by setting BA and BS to a one, that cycle will be a dead cycle, used to transfer bus master ship to the DMA controller.

False memory accesses may be prevented during any dead cycles by developing a system DMAVMA signal which is LOW in any cycle when BA has changed.

FIGURE 11 — E/Q RELATIONSHIP

NOTE: Waveform measurements for all inputs and outputs are specified at logic high 2.0 V and logic low 0.8 V unless otherwise specified.

*The on board clock generator furnishes E and Q to both the system and the MPU. When MRDY is pulled low, both the system clocks are stretched. Assertion of DMA-BREQ input stops the internal MPU clocks while allowing the external system clocks to RUN (i.e., release the bus to a DMA controller). The internal MPU clocks resume operation after DMA-BREQ is released or after 16 bus cycles (14 DMA, two dead), whichever occurs first. While DMA-BREQ is asserted it is sometimes necessary to pull MRDY low to allow DMA to/from slow memory peripherals. As both MRDY and DMA-BREQ control the internal MPU clocks, care must be exercised not to violate the maximum t_{CYC} specification for MRDY or DMA-BREQ. (Maximum t_{CYC} during MRDY or DMA-BREQ is 16 μs .)

When BA goes low (either as a result of $\overline{\text{DMA_BREQ}} = \text{HIGH}$ or MPU self refresh), the DMA device should be taken off the bus. Any other bus cycle will lapse before the MPU accesses memory, to allow transfer of bus mastership without contention.

MPU OPERATION

During normal operation, the MPU fetches an instruction from memory and then executes the requested function.

This sequence begins after $\overline{\text{RESET}}$ and is repeated indefinitely unless altered by a special instruction or hardware occurrence. Software instructions that alter normal MPU operation are: $\overline{\text{SWI}}$, $\overline{\text{SWI2}}$, $\overline{\text{SWI3}}$, $\overline{\text{CWI}}$, $\overline{\text{RTI}}$, and $\overline{\text{SYNC}}$. An interrupt, $\overline{\text{HALT}}$, or $\overline{\text{DMA_BREQ}}$ can also alter the normal execution of instructions. Figure 15 illustrates the flowchart for the EF6809.

FIGURE 12 — MRDY TIMING AND SYNCHRONIZATION

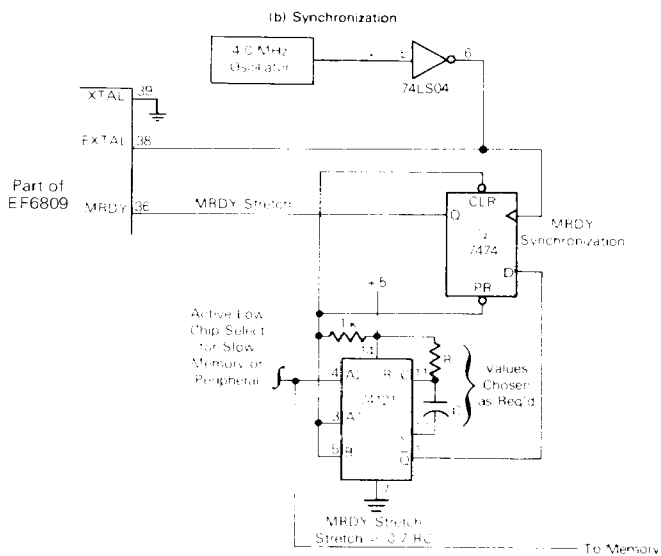
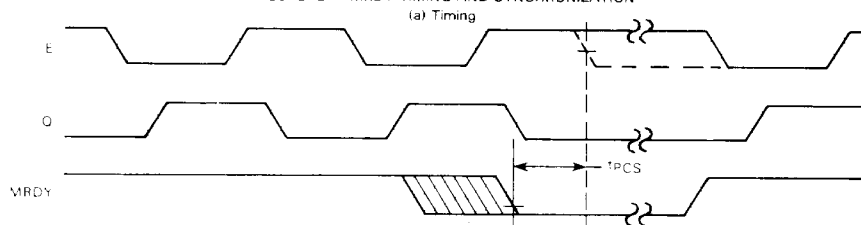
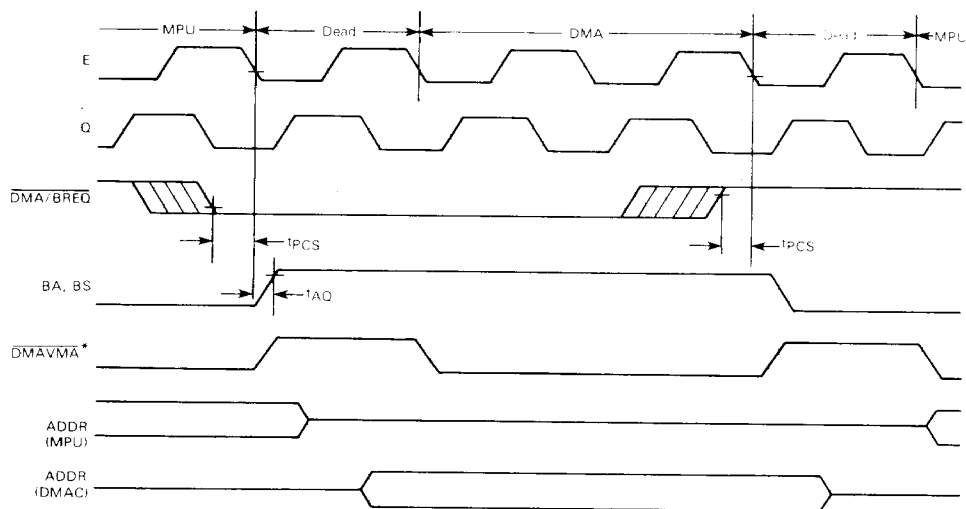
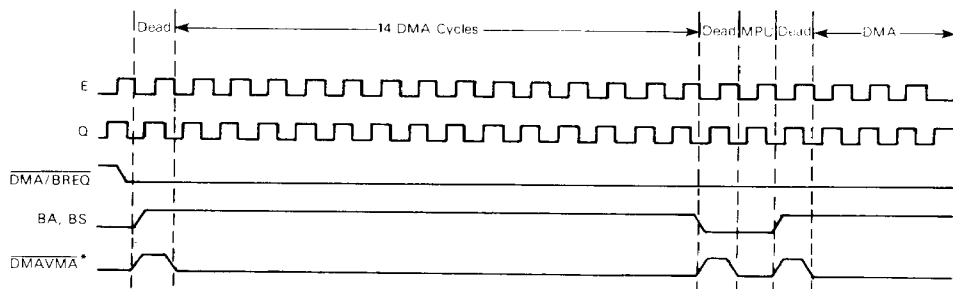
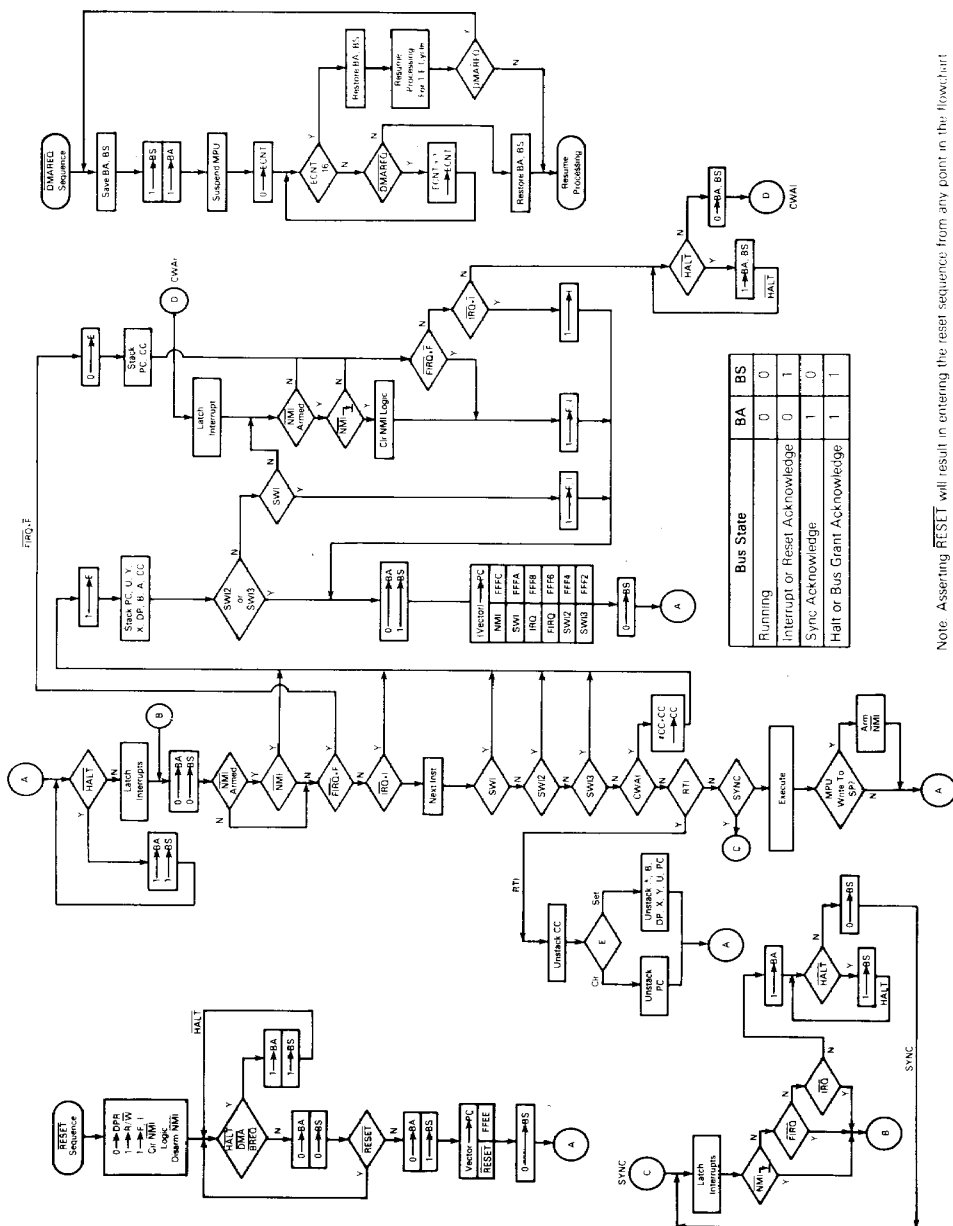


FIGURE 13 — TYPICAL DMA TIMING (< 14 CYCLES)

FIGURE 14 — AUTO-REFRESH DMA TIMING (> 14 CYCLES)
(REVERSE CYCLE STEALING)

* DMAVMA is a signal which is developed externally, but is a system requirement for DMA

NOTE: Waveform measurements for all inputs and outputs are specified at logic high 2.0 V and logic low 0.8 V, unless otherwise specified.



Note. Asserting RESET will result in entering the reset sequence from any point in the flowchart.

ADDRESSING MODES

The basic instructions of any computer are greatly enhanced by the presence of different addressing modes. The EF6809 has the most complete set of addressing modes available on any microcomputer today. For example, the EF6809 has 59 basic instructions, however it recognizes 1464 different variations of instructions and addressing modes. The addressing modes support modern programming techniques. The following addressing modes are available on the EF6809:

- Inherent (includes accumulator)
- Immediate
- Extended
- Extended Indirect
- Direct
- Register
- Indexed
 - Zero Offset
 - Constant Offset
 - Accumulator Offset
 - Auto-Increment/Decrement
- Indexed Indirect
- Relative
 - Short/Long Relative Branching
 - Program Counter Relative Addressing

INHERENT (INCLUDES ACCUMULATOR)

In this addressing mode, the opcode of the instruction contains all the address information necessary. Examples of inherent addressing are ARX, BAA, SWI, ASRA, and CLRB.

IMMEDIATE ADDRESSING

In immediate addressing, the effective address of the data is the location immediately following the opcode, i.e., the data to be used in the instruction. Immediate addressing is the opcode of the instruction. The EF6809 uses 8-bit and 16-bit immediate values depending on the size of operand specified by the opcode. Examples of instructions with their immediate addressing are:

```
LDA #52H
LDX #5F00H
LDY #CAT
```

NOTE

signifies immediate addressing, \$ signifies stack relative value.

EXTENDED ADDRESSING

In extended addressing, the contents of the two bytes immediately following the opcode fully specify the 16-bit effective address used by the instruction. Note that the address generated by an extended instruction defines an absolute address and is not position independent. Examples of extended addressing include:

```
LDA CAT
STX MOUSE
LDD $2000
```

EXTENDED INDIRECT As in the special case of indexed addressing (discussed below), one level of indirection may be added to extended addressing. In extended indirect, the two bytes following the postbyte of an indexed instruction contain the address of the data.

```
LDA [CAT]
LDX [$FFE]
STX [DOG]
```

DIRECT ADDRESSING

Direct addressing is similar to extended addressing except that only one byte of address follows the opcode. This byte specifies the lower eight bits of the address to be used. The upper eight bits of the address are supplied by the direct page register. Since only one byte of address is required in direct addressing, this mode requires less memory and executes faster than extended addressing. Of course, only 256 locations (one page) can be accessed without redefining the contents of the DP register. Since the DP register is set to \$00 on reset, direct addressing on the EF6809 is compatible with direct addressing on the 6800. Indirect is not allowed in direct addressing. Some examples of direct addressing are:

```
LDA 19H
SETDP $N (assembler directive)
LDB $100H
LDD <CAT
```

NOTE

< is an assembler directive which forces direct addressing.

REGISTER ADDRESSING

Some opcodes are followed by a byte that defines a register or set of registers to be used by the instruction. This is called a postbyte. Some examples of register addressing are:

TFR	X, Y	Transfers X into Y
FXG	A, B	Exchanges A with B
PSHS	A, B, X, Y	Push Y, X, B and A onto S
PULU	X, Y, D	Pop D, X, and Y from U

INDEXED ADDRESSING

In all indexed addressing, one of the pointer registers (X, Y, U, S), and sometimes PC is used in a calculation of the effective address of the operand to be used by the instruction. Five basic types of indexing are available and are discussed below. The postbyte of an indexed instruction specifies the basic type and variation of the addressing mode as well as the pointer register to be used. Figure 16 lists the legal formats for the postbyte. Table 2 gives the assembler form and the number of cycles and bytes added to the basic values for indexed addressing for each variation.

FIGURE 16 — INDEXED ADDRESSING POSTBYTE REGISTER BIT ASSIGNMENTS

Postbyte Register Bit								Indexed Addressing Mode
7	6	5	4	3	2	1	0	
0	R	R	d	d	d	d	d	EA = R + 5 Bit Offset
1	R	R	0	0	0	0	0	EA = R +
1	R	R	i	0	0	0	1	EA = R + +
1	R	R	0	0	0	1	0	EA = R -
1	R	R	i	0	0	1	1	EA = R - R
1	R	R	i	0	1	0	0	EA = R + 0 Offset
1	R	R	i	0	1	0	1	EA = R + ACCB Offset
1	R	R	i	0	1	1	0	EA = R + ACCA Offset
1	R	R	i	1	0	0	0	EA = R + 8 Bit Offset
1	R	R	i	1	0	0	1	EA = R + 16 Bit Offset
1	R	R	i	1	0	1	1	EA = R + D Offset
1	x	x	i	1	1	0	0	EA = PC + 8 Bit Offset
1	x	x	i	1	1	0	1	EA = PC + 16 Bit Offset
1	R	R	i	1	1	1	1	EA = [Address]

Addressing Mode Field

Indirect Field
(Sign bit when b7 = 0)

Register Field RR

x = Don't Care
d = Offset Bit
0 = Not Indirect
1 = Indirect

00 = X
01 = Y
10 = U
11 = S

ZERO-OFFSET INDEXED -- In this mode, the selected pointer register contains the effective address of the data to be used by the instruction. This is the fastest indexing mode.

Examples are:

```
LDD 0,X
LDA S
```

CONSTANT OFFSET INDEXED -- In this mode, a two's complement offset and the contents of one of the pointer registers are added to form the effective address of the operand. The pointer register's initial content is unchanged by the addition.

Three sizes of offsets are available

5 bit (-16 to +15)

8 bit (-128 to +127)

16 bit (-32768 to +32767)

The two's complement 5-bit offset is included in the postbyte and, therefore, is most efficient in use of bytes and cycles. The two's complement 8-bit offset is contained in a single byte following the postbyte. The two's complement 16-bit offset is in the two bytes following the postbyte. In most cases the programmer need not be concerned with the size of this offset since the assembler will select the optimal size automatically.

Examples of constant-offset indexing are

```
LDA 23,X
LDX -2,S
LDY 300,X
LDU CAT,Y
```

TABLE 2 — INDEXED ADDRESSING MODE

Type	Forms	Non Indirect		+	~	#	Indirect		+	~	#
		Assembler Form	Postbyte Opcode				Assembler Form	Postbyte Opcode			
Constant Offset From R	No Offset	,R	1RR00100	0	0		[,R]	1RR10100	3	0	
12s Complement Offsets	5-Bit Offset	n, R	0RRnnnnn	1	0		defaults to 8-bit				
	8-Bit Offset	n, R	1RR01000	1	1		[n, R]	1RR11000	4	1	
	16-Bit Offset	n, R	1RR01001	4	2		[n, R]	1RR11001	7	2	
Accumulator Offset From R (2s Complement Offsets)	A Register Offset	A, R	1RR00110	1	0		[A, R]	1RR10110	4	0	
	B Register Offset	B, R	1RR00101	1	0		[B, R]	1RR10101	4	0	
	D Register Offset	D, R	1RR01011	4	0		[D, R]	1RR11011	7	0	
Auto Increment/Decrement R	Increment By 1	,R +	1RR00000	2	0		not allowed				
	Increment By 2	,R + +	1RR00001	3	0		[,R + +]	1RR10001	6	0	
	Decrement By 1	,R -	1RR00010	2	0		not allowed				
	Decrement By 2	,R - -	1RR00011	3	0		[,R - -]	1RR10011	6	0	
Constant Offset From PC (2s Complement Offsets)	8-Bit Offset	n, PCR	1xx01100	1	1		[n, PCR]	1xx11100	4	1	
	16-Bit Offset	n, PCR	1xx01101	5	2		[n, PCR]	1xx11101	8	2	
Extended Indirect	16 Bit Address	-	-	-	-		[n]	10011111	5	2	

R = X, Y, U, or S
x = Don't Care
00 = X
01 = Y
10 = U
11 = S

⁺ and [#] indicate the number of additional cycles and bytes for the particular variation

ACCUMULATOR-OFFSET INDEXED This mode is similar to constant offset indexed except that the two's complement value in one of the accumulators (A, B, or D) and the contents of one of the pointer registers are added to form the effective address of the operand. The contents of both the accumulator and the pointer register are unchanged by the addition. The positive specifies which accumulator to use as an offset and no additional bytes are required. The advantage of an accumulator offset is that the value of the offset can be calculated by a program at run-time.

Some examples are:

```
LDA  B,Y
LDX  D,Y
LEAX B,X
```

AUTO INCREMENT/DECREMENT INDEXED In the auto increment addressing mode, the pointer register contains the address of the operand. Then, after the pointer register is used it is incremented by one or two. This addressing mode is useful in stepping through tables, moving data, or for the creation of software stacks. In auto-decrement, the pointer register is decremented prior to use as the address of the data. The use of auto-decrement is similar to that of auto-increment, but the tables, etc., are scanned from the high to low addresses. The size of the increment/decrement can be either one or two to allow for tables of either 8- or 16-bit data to be accessed and is selectable by the programmer. The pre-decrement, post-increment nature of these modes allows them to be used to create additional software stacks that behave identically to the U and S stacks.

Some examples of the auto-increment/decrement addressing modes are:

```
LDA  ,X+
STD  ,Y+
LDB  , -Y
LDX  , -S
```

Care should be taken in performing operations on 16-bit pointer registers (X, Y, U, S) where the same register is used to calculate the effective address.

Consider the following instruction:

```
STX 0,X++ (X initialized to 0)
```

The desired result is to store zero in locations \$0000 and \$0001 then increment X to point to \$0002. In reality, the following occurs:

```
0 → temp      calculate the EA; temp is a holding register
X + 2 → X      perform auto-increment
X → (temp)     do store operation
```

INDEXED INDIRECT — All of the indexing modes, with the exception of auto-increment/decrement by one or a ± 4 -bit offset, may have an additional level of indirection specified. In indirect addressing, the effective address is contained at the location specified by the contents of the index register plus any offset. In the example below, the A accumulator is loaded indirectly using an effective address calculated from the index register and an offset.

Before Execution:

A ← X, don't care

X ← \$F000

```
$0100 LDA  ($10,X)  LA is now $F010
```

```
$F010 $F1          $F15 ← now the
$F011 $50          new EA
```

```
$F150
```

AAA

After Execution:

A ← AAA Actual Data loaded

X ← \$F000

All modes of indexed indirect are included except those which are meaningless (e.g., auto-increment/decrement by one indirect). Some examples of indexed indirect are:

```
LDA  ,X
LDD  ,D(S
LDA  ,B(Y)
LDD  ,X,X++
```

RELATIVE ADDRESSING

The instruction following the branch opcode is treated as a signed offset which may be added to the program counter. If the branch condition is true, then the calculated address (PC + signed offset) is loaded into the program counter. Program execution continues at the new location as indicated by the PC. Short-form byte offset and long-form two bytes offset relative addressing modes are available. An effective address is interpreted modulo 2^{16} . Some examples of relative addressing are:

	BEG	CAT	(short)
	BGT	DOG	(short)
CAT	LBEG	RA*	(long)
DOG	LBGT	RABBIT	(long)
	•		
	•		
	•		
RAT	NOF		
RABBIT	NOP		

PROGRAM COUNTER RELATIVE The PC can be used as the pointer register with 8- or 16-bit signed offsets. As in relative addressing, the offset is added to the current PC to create the effective address. The effective address is then used as the address of the operand or data. Program counter relative addressing is used for writing position-independent programs. Tables related to a particular routine will maintain the same relationship after the routine is moved or referenced relative to the program counter. Examples are:

```
LDA  CAT, PCR
LEAX TABLE, PCR
```

Since program counter relative is a type of indirect, an additional level of indirection is available.

```
LDA  (CAT, PCR)
LDU  (DOG, PCR)
```

INSTRUCTION SET

The instruction set of the EF6809E is similar to that of the 6800 and is upward compatible at the source code level. The number of opcodes has been reduced from 72 to 59, but because of the expanded architecture and additional addressing modes, the number of available opcodes (with different addressing modes) has risen from 197 to 1464.

Some of the new instructions are described in detail below.

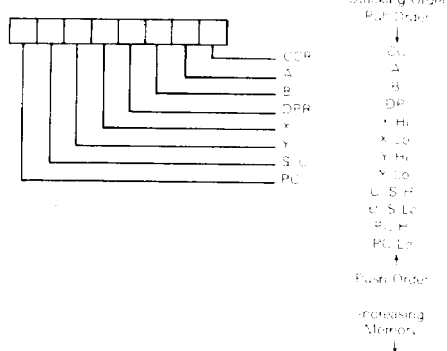
PSHU/PSHS

The push instructions have the capability of pushing onto either the hardware stack (S) or user stack (U) any single register or set of registers with a single instruction.

PULU/PULS

The pull instructions have the same capability of the push instruction, in reverse order. The byte immediately following the push or pull opcode determines which register or registers are to be pushed or pulled. The actual push/pull sequence is fixed, each bit defines a unique register to push or pull, as shown below.

Push/Pull Postbyte



TFR/EXG

Within the EF6809E, any register may be transferred to or exchanged with another of like size, i.e., 8 bit to 8 bit or 16 bit to 16 bit. Bits 4-7 of postbyte define the source register, while bits 0-3 represent the destination register. These are denoted as follows:

Transfer/Exchange Postbyte	
Source	Destination
Register Field	
0000 = D, A, B	1000 = A
0001 = X	1001 = B
0010 = Y	1010 = CCR
0011 = U	1011 = DRR
0100 = S	
0101 = PC	

NOTE

All other combinations are undefined and INVALID.

LEAX/LEAY/LEAU/LEAS

The LEA (load effective address) works by calculating the effective address used in an indexed instruction and stores that address value, rather than the data at that address, in a pointer register. This makes all the features of the internal addressing hardware available to the programmer. Some of the implications of this instruction are illustrated in Table 3.

The LEA instruction also allows the user to access data and tables in a position independent manner. For example:

```
LEAX MSG1, PCR
LSR      PDATA (print message routine)
•
•
MSG1     FCL      MESSAGE
```

This sample program prints "MESSAGE". By writing MSG1, PCR, the assembler computes the distance between the present address and MSG1. This result is placed as a constant into the LEAX instruction which will be indexed from the PC value at the time of execution. No matter where the code is located when it is executed, the computed offset from the PC will put the also the address of MSG1 into the X pointer register. This code is totally position independent.

The LEA instructions are very powerful and use an internal holding register (temp). Care must be exercised when using the LEA instructions with the auto-increment and auto-decrement addressing modes due to the sequence of internal operations. The LEA internal sequence is outlined as follows:

LEAa, b+ any of the 16 bit pointer registers X, Y, S, or U may be substituted for a and b

1. b → temp calculate the EA
2. b + 1 → b modify b to postincrement
3. temp → a load a

LEAa, b- b

1. b - 1 → temp calculate EA with predecrement
2. b - 1 → b modify b to predecrement
3. temp → a load a

TABLE 3 — LEA EXAMPLES

Instruction	Operation	Comment
LEAX 10, X	X + 10 → X	Adds 10 Bit Constant 10 to X
LEAX 500, X	X + 500 → X	Adds 16 Bit Constant 500 to X
LEAY A, Y	Y + A → Y	Adds 8 Bit A Accumulator to Y
LEAY D, Y	Y + D → Y	Adds 16 Bit D Accumulator to Y
LEAU -10, U	U - 10 → U	Subtracts 10 from U
LEAS -10, S	S - 10 → S	Used to Reserve Area on Stack
LEAS 10, S	S + 10 → S	Used to Clear Up Stack
LEAX 5, S	S + 5 → X	Transfers 5 Bytes from Stack

Auto increment by two and auto decrement by two instructions work similarly. Note that LEAX, X+ does not change X, however, LEAX, X- does decrement. LEAX, 1, X should be used to increment X by one.

MUL

Multiplies the unsigned binary numbers in the A and B accumulators and places the unsigned result into the 16-bit D accumulator. The unsigned multiply also allows multiple-precision multiplications.

LONG AND SHORT RELATIVE BRANCHES

The EF6809 has the capability of program counter relative branching throughout the entire memory map. In this mode, if the branch is to be taken, the 8- or 16-bit signed offset is added to the value of the program counter to be used as the effective address. This allows the program to branch anywhere in the 64K memory map. Position-independent code can be easily generated through the use of relative branching. Both short (8-bit) and long (16-bit) branches are available.

SYNC

After encountering a sync instruction, the MPU enters a sync state, stops processing instructions, and waits for an interrupt. If the pending interrupt is non-maskable (NMI) or maskable (IRQ, IREQ) with its mask bit (IF or IEF) clear, the processor will clear the sync state and perform the normal interrupt stacking and service routine. Since IRQ and IREQ are not edge-triggered, a low level with a minimum duration of three bus cycles is required to assure that the interrupt will be taken. If the pending interrupt is maskable (IRQ, IREQ) with its mask bit (IF or IEF) set, the processor will clear the sync state and continue processing by executing the next in-line instruction. Figure 17 depicts sync timing.

SOFTWARE INTERRUPTS

A software interrupt is an instruction which will cause an interrupt and its associated vector fetch. These software interrupts are useful in operating system calls, software debugging, trace operations, memory mapping, and software development systems. Three levels of SWI are available on the EF6809, and are prioritized in the following order: SWI, SWI2, SWI3.

16-BIT OPERATION

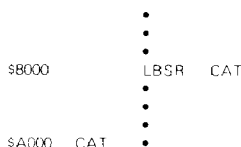
The EF6809 has the capability of processing 16-bit data. These instructions include loads, stores, compares, adds, subtracts, transfers, exchanges, pushes, and pulls.

CYCLE-BY-CYCLE OPERATION

The address bus cycle-by-cycle performance chart (Figure 18) illustrates the memory access sequence corresponding to each possible instruction and addressing mode in the EF6809. Each instruction begins with an opcode fetch. While that opcode is being internally decoded, the next program byte is always fetched. (Most instructions will use the next byte, so this technique considerably speeds throughput.) Next, the operation of each opcode will follow the flowchart. VMA is an abbreviation of VMA16 on the address bus. R/W = 1 and BS = 0. The following examples illustrate the use of the chart.

Example 1: LBSR (Branch Taken)

Before Execution: SP = F000



CYCLE-BY-CYCLE FLOW

Cycle #	Address	Data	R/W	Description
1	8000	17	1	Opcode Fetch
2	8001	20	1	Offset High Byte
3	8002	00	1	Offset Low Byte
4	FFFF	*	1	VMA Cycle
5	FFFF	*	1	VMA Cycle
6	A000	*	1	Computed Branch Address
7	FFFF	*	1	VMA Cycle
8	FFFF	80	0	Stack High Order Byte of Return Address
9	FFFF	03	0	Stack Low Order Byte of Return Address

Example 2: DEC (Extended)

\$8000 DEC \$A000



CYCLE-BY-CYCLE FLOW

Cycle #	Address	Data	R/W	Description
1	8000	7A	1	Opcode Fetch
2	8001	A0	1	Operand Address, High Byte
3	8002	00	1	Operand Address, Low Byte
4	FFFF	*	1	VMA Cycle
5	A000	80	1	Read the Data
6	FFFF	*	1	VMA Cycle
7	A000	7F	0	Store the Decrement Data

* The data bus has the data at that particular address.

INSTRUCTION SET TABLES

The instructions of the EF6809 have been broken down into five different categories. They are as follows:

- 8-bit operation (Table 4)
 - 16-bit operation (Table 5)
 - Index register/stack pointer instructions (Table 6)
 - Relative branches (long or short) (Table 7)
 - Miscellaneous instructions (Table 8)
- Hexadecimal values for the instructions are given in Table 9.

PROGRAMMING AID

Figure 19 contains a compilation of data that will assist in programming the EF6809.

The diagram illustrates the timing of the 68000 microprocessor, showing the sequence of events for an instruction cycle and a data cycle. The diagram is divided into two main sections: 'Instruction Cycle' and 'Data Cycle'.

Instruction Cycle:

- Instruction Fetch:** The instruction is fetched from memory. The Address bus shows the instruction address, and the Data bus shows the instruction data.
- Instruction Decode:** The instruction is decoded. The Address bus shows the instruction address, and the Data bus shows the instruction data.
- Instruction Execute:** The instruction is executed. The Address bus shows the instruction address, and the Data bus shows the instruction data.
- Instruction Writeback:** The instruction is written back to memory. The Address bus shows the instruction address, and the Data bus shows the instruction data.

Data Cycle:

- Data Read:** Data is read from memory. The Address bus shows the data address, and the Data bus shows the data.
- Data Write:** Data is written to memory. The Address bus shows the data address, and the Data bus shows the data.
- Data Execute:** The data is executed. The Address bus shows the data address, and the Data bus shows the data.
- Data Writeback:** The data is written back to memory. The Address bus shows the data address, and the Data bus shows the data.

The diagram includes signals for Address, Data, R/W, BA, BS, and NMI. The NMI signal is shown as a pulse that occurs during the Instruction Execute phase.

[illegible]

- ### 5. Waveform measurements for an inputs or specified output high, V_{OH} and low, V_{OL} , or V_{IH} and V_{IL} values, or for any specified

FIGURE 18 — CYCLE-BY-CYCLE PERFORMANCE (Sheet 1 of 9)

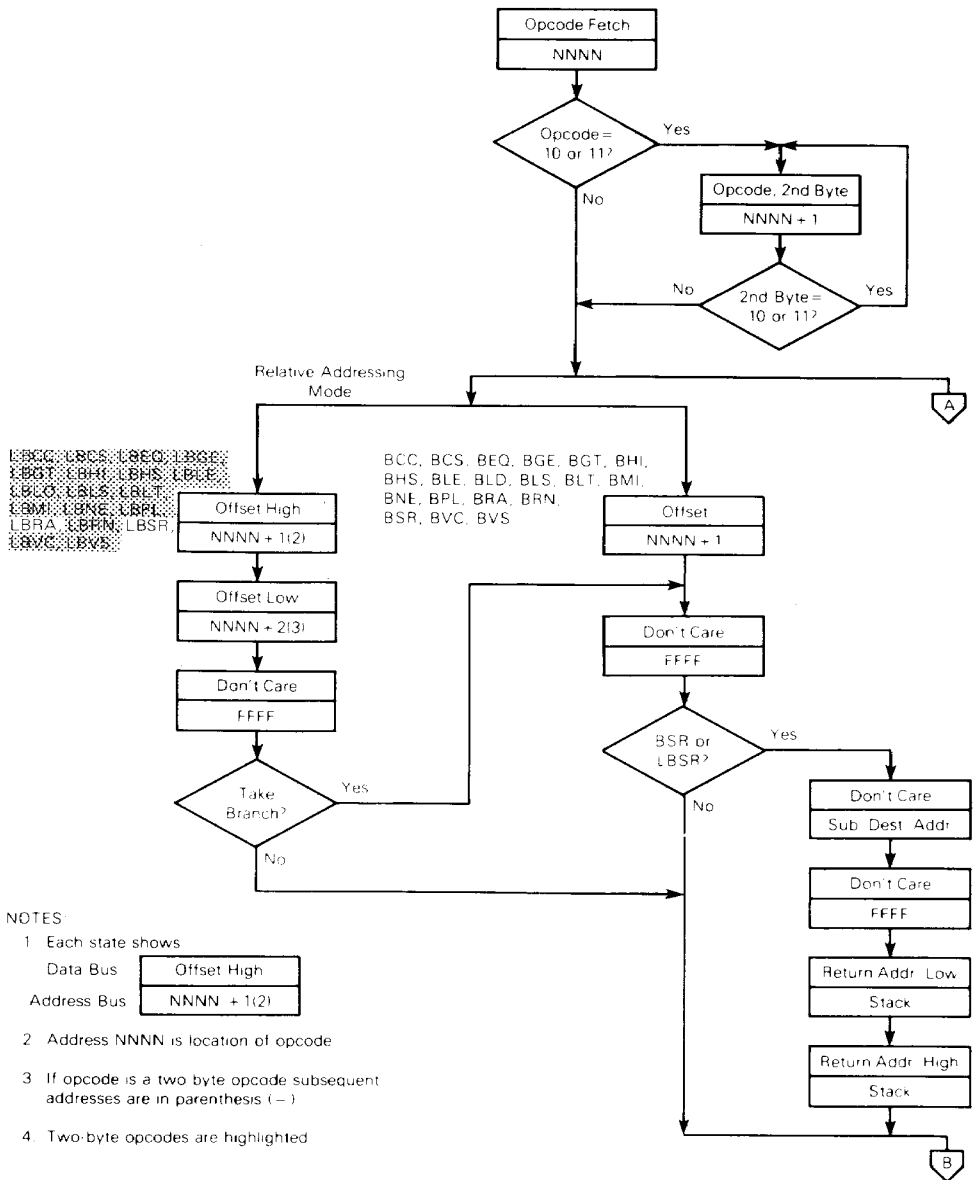


FIGURE 18 – CYCLE-BY-CYCLE PERFORMANCE (Sheet 2 of 9)

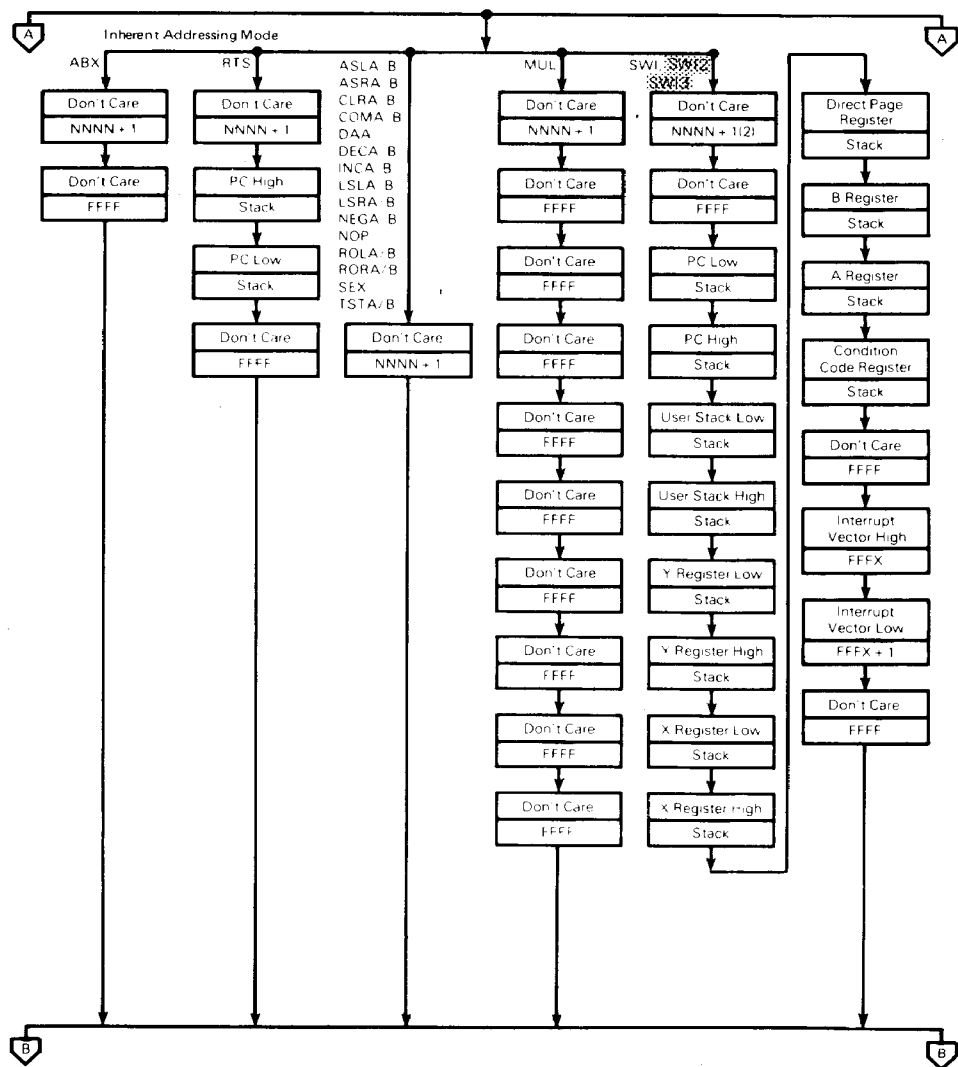


FIGURE 18 — CYCLE-BY-CYCLE PERFORMANCE (Sheet 3 of 9)

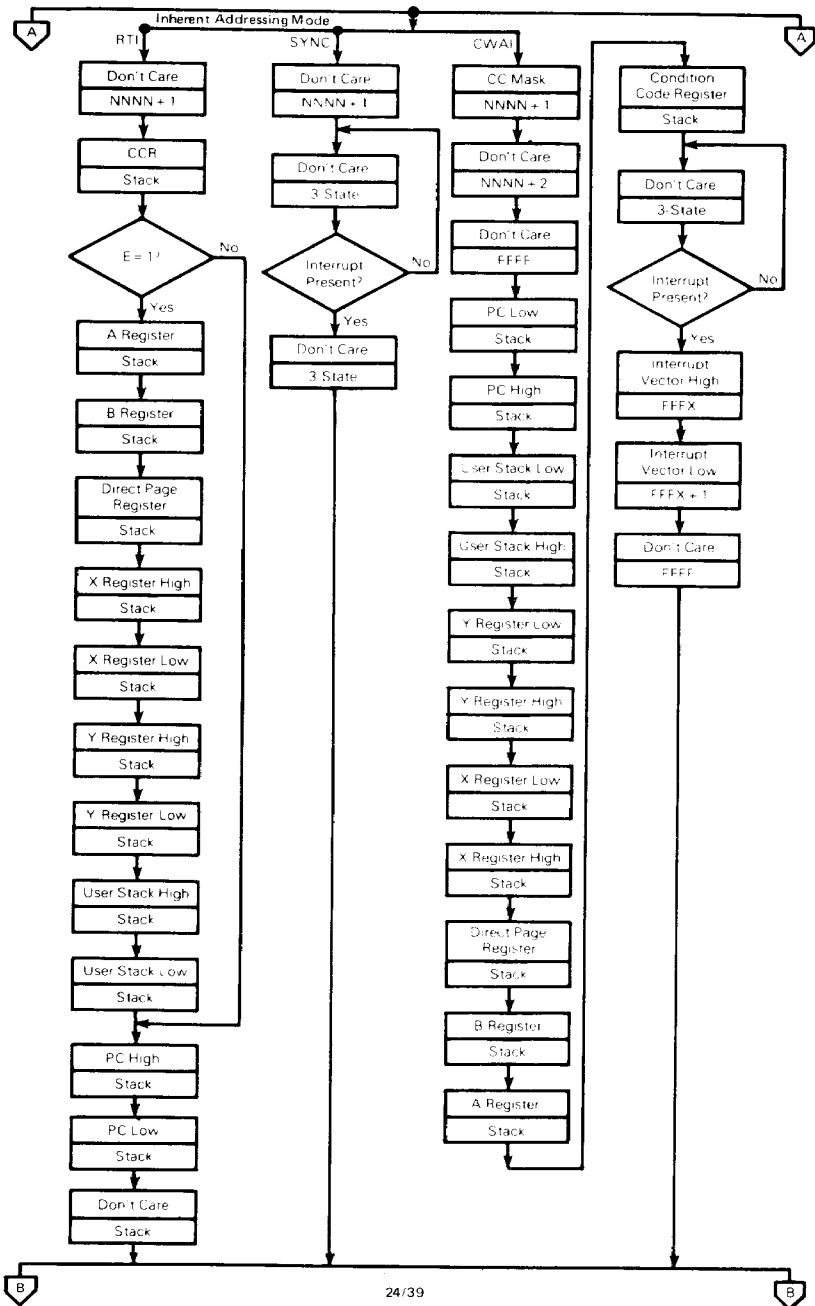


FIGURE 18 — CYCLE-BY-CYCLE PERFORMANCE (Sheet 4 of 9)

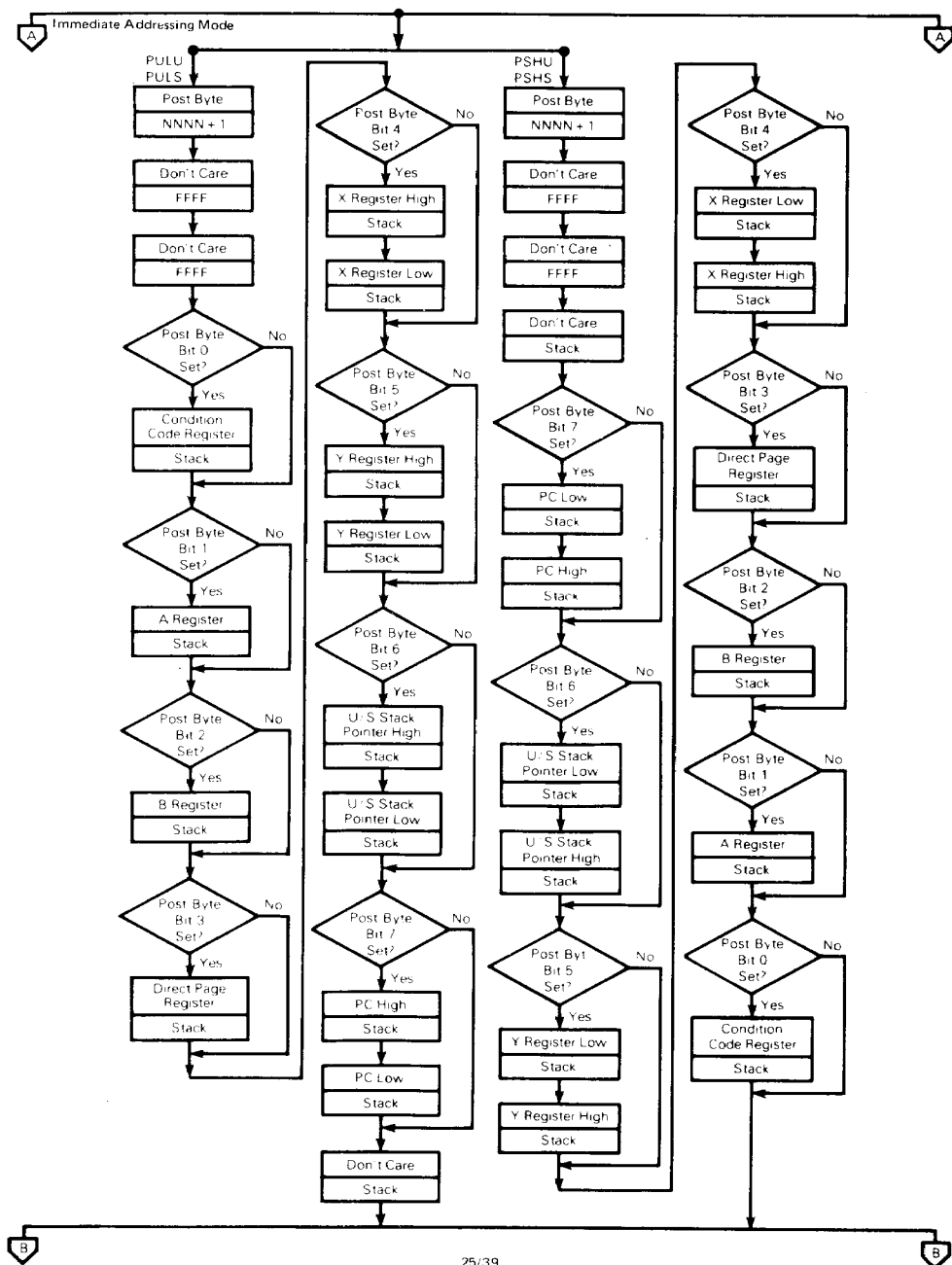


FIGURE 18 – CYCLE-BY-CYCLE PERFORMANCE (Sheet 5 of 9)

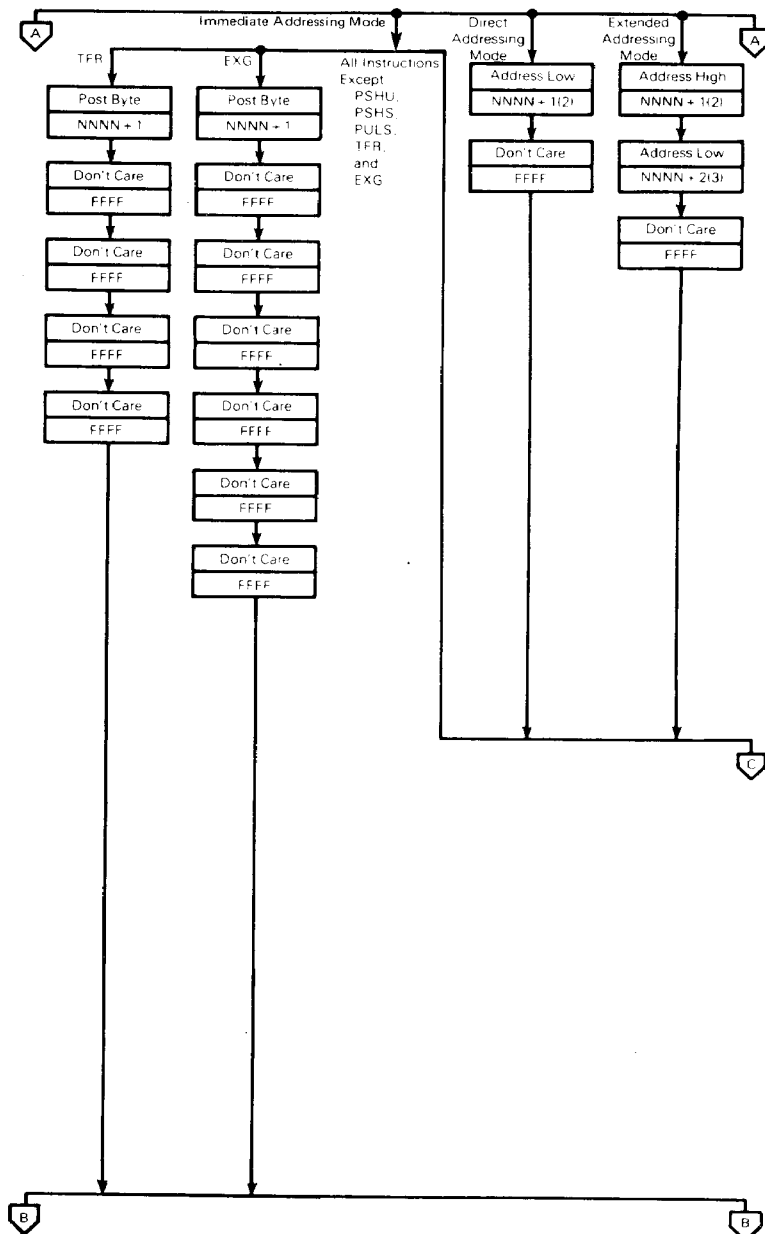


FIGURE 18 – CYCLE-BY-CYCLE PERFORMANCE (Sheet 6 of 9)

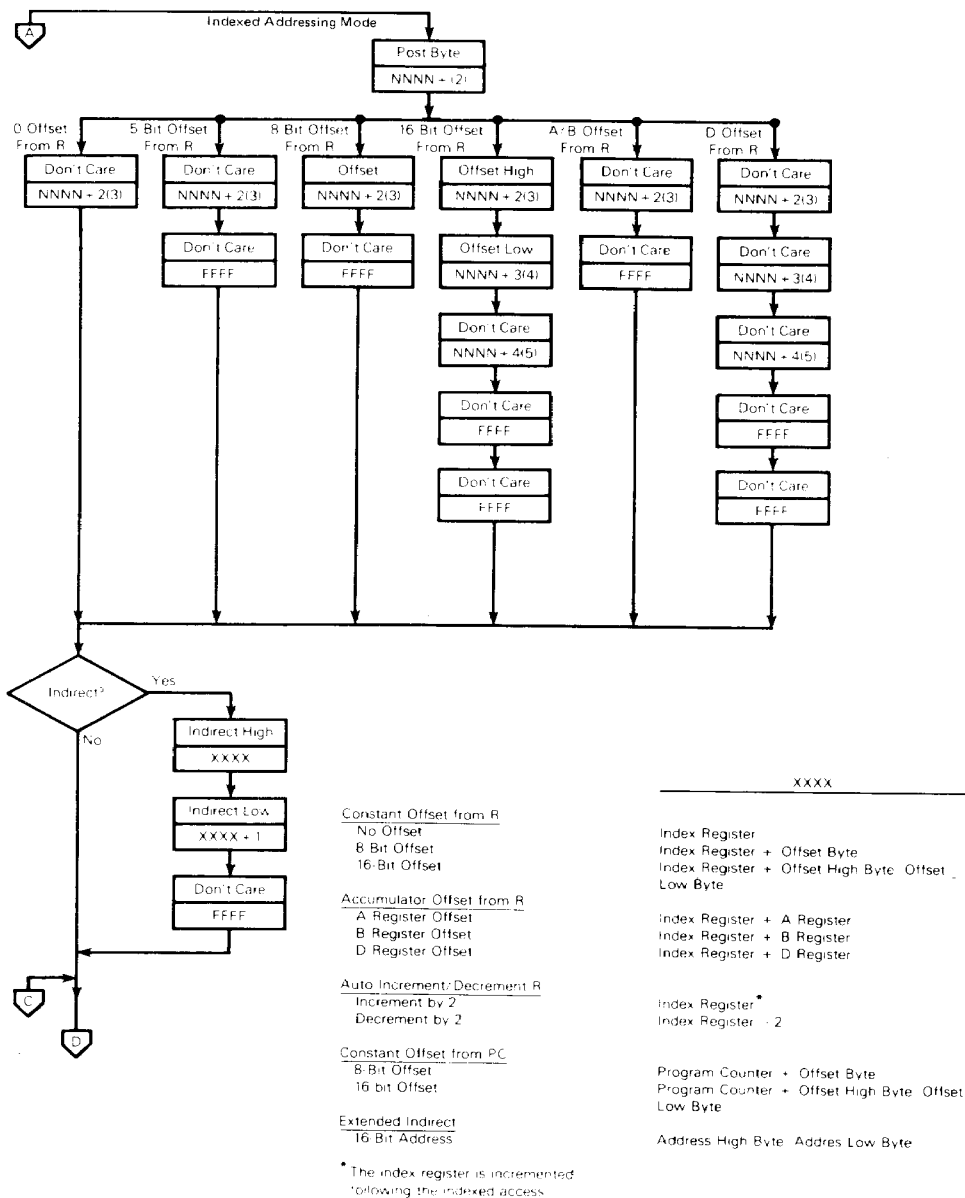


FIGURE 18 – CYCLE-BY-CYCLE PERFORMANCE (Sheet 7 of 9)

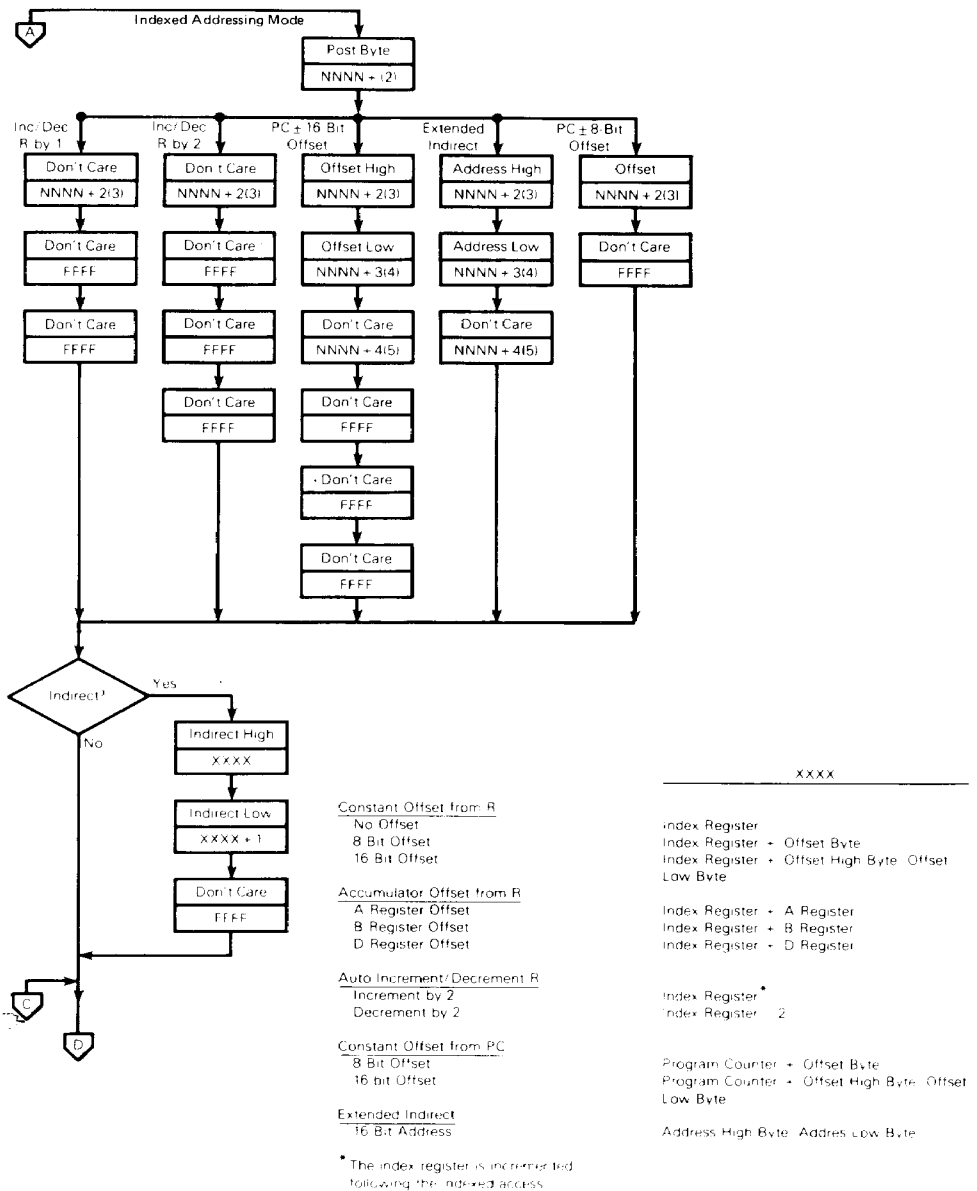
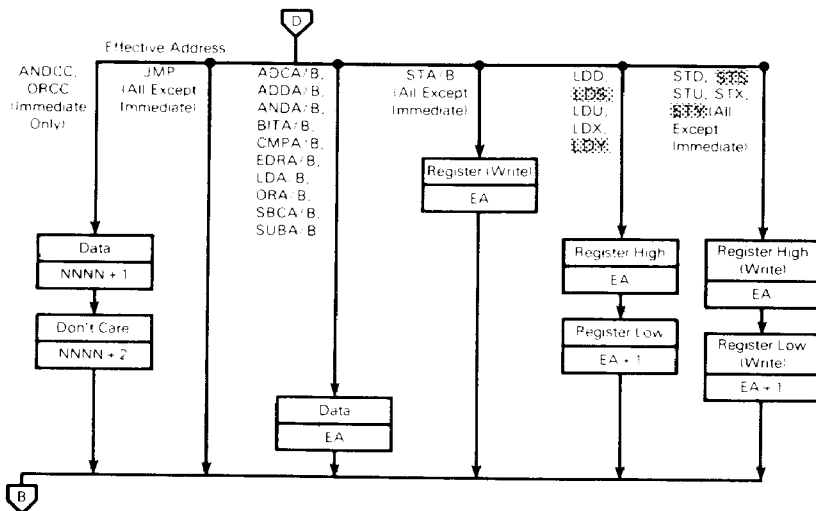


FIGURE 18 — CYCLE-BY-CYCLE PERFORMANCE (Sheet 8 of 9)



Effective Address (EA):

Constant Offset from R

No Offset
5 Bit Offset
8 Bit Offset
16 Bit Offset

Accumulator Offset from R

A Register Offset
B Register Offset
D Register Offset

Auto Increment / Decrement R

Increment by 1
Increment by 2
Decrement by 1
Decrement by 2

Constant Offset from PC

8 Bit Offset
16 Bit Offset

DirectExtendedImmediate

* The index register is incremented following the indexed address.

Index Register

Index Register

Index Register + Post Byte

Index Register + Post Byte High - Post Byte Low

Index Register + A Register

Index Register + B Register

Index Register + D Register

Index Register

Index Register

Index Register

Index Register + 2

Program Counter + Offset Byte

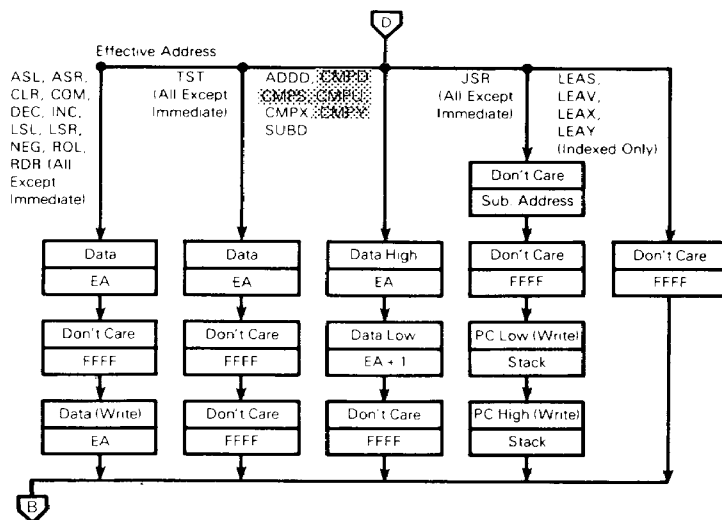
Program Counter + Offset High Byte - Offset Low Byte

Direct Page Register Address Low

Address High - Address Low

NNNN + 1

FIGURE 18 – CYCLE-BY-CYCLE PERFORMANCE (Sheet 9 of 5)

Constant Offset from R

No Offset
5-Bit Offset
8-Bit Offset
16-Bit Offset

Accumulator Offset from R

A Register Offset
B Register Offset
D Register Offset

Auto-Increment/Decrement R

Increment by 1
Increment by 2
Decrement by 1
Decrement by 2

Constant Offset from PC

8-Bit Offset
16-Bit Offset

DirectExtendedImmediate

- The index register is incremented following the indexed access

Effective Address (EA):

Index Register
Index Register
Index Register + Post Byte
Index Register + Post Byte High Post Byte Low

Index Register + A Register
Index Register + B Register
Index Register + D Register

Index Register
Index Register
Index Register + 1
Index Register + 2

Program Counter + Offset Byte
Program Counter + Offset High Byte Offset Low Byte

Direct Page Register Address Low

Address High Address Low

NNNN + 1

TABLE 4 — 8-BIT ACCUMULATOR AND MEMORY INSTRUCTIONS

Mnemonic(s)	Operation
ADCA, ADCB	Add memory to accumulator with carry
ADDA, ADDB	Add memory to accumulator
ANDA, ANDB	And memory with accumulator
ASL, ASLA, ASLB	Arithmetic shift of accumulator or memory left
ASR, ASRA, ASRB	Arithmetic shift of accumulator or memory right
BITA, BITB	Bit test memory with accumulator
CLR, CLRA, CLRB	Clear accumulator or memory location
CMFA, CMPB	Compare memory from accumulator
COM, COMA, COMB	Complement accumulator or memory location
DAA	Decimal adjust A accumulator
DEC, DECA, DECB	Decrement accumulator or memory location
EORA, EORB	Exclusive or memory with accumulator
EXG R1, R2	Exchange R1 with R2 (R1, R2 = A, B, CC, DP)
INC, INCA, INCB	Increment accumulator or memory location
LDA, LDB	Load accumulator from memory
LSL, LSALA, LSLB	Logical shift left accumulator or memory location
LSR, LSRA, LSRB	Logical shift right accumulator or memory location
MUL	Unsigned multiply ($A \times B = D$)
NEG, NEGA, NEGB	Negate accumulator or memory
ORA, ORB	Or memory with accumulator
ROL, ROLA, ROLB	Rotate accumulator or memory left
ROR, RORA, RORB	Rotate accumulator or memory right
SBCA, SBCB	Subtract memory from accumulator with borrow
STA, STB	Store accumulator to memory
SUBA, SUBB	Subtract memory from accumulator
TST, TSTA, TSTB	Test accumulator or memory location
TFR R1, R2	Transfer R1 to R2 (R1, R2 = A, B, CC, DP)

NOTE: A, B, CC, or DP may be pushed to (pulled from) stack with either PSHS, PSHU (PULS, PULU) instructions

TABLE 5 — 16-BIT ACCUMULATOR AND MEMORY INSTRUCTIONS

Mnemonic(s)	Operation
ADD	Add memory to D accumulator
CMPD	Compare memory from D accumulator
EXG D, R	Exchange D with X, Y, S, U, or PC
LDD	Load D accumulator from memory
SEX	Sign Extend B accumulator into A accumulator
STD	Store D accumulator to memory
SUBD	Subtract memory from D accumulator
TFR D, R	Transfer D to X, Y, S, U, or PC
TFR R, D	Transfer X, Y, S, U, or PC to D

NOTE: D may be pushed (pulled) to stack with either PSHS, PSHU (PULS, PULU) instructions.

TABLE 6 — INDEX REGISTER/STACK POINTER INSTRUCTIONS

Instruction	Description
CMPS, CMPI	Compare memory from stack pointer
CMPX, CMPI	Compare memory from index register
EXG R1, R2	Exchange D, X, Y, S, or PC with D, X, Y, S, or PC
LEAS, LEAU	Load effective address into stack pointer
LEAX, LEAY	Load effective address into index register
LDS, LDU	Load stack pointer from memory
LDX, LDY	Load index register from memory
PSHS	Push A, B, CC, DP, D, X, Y, U, or PC onto hardware stack
PSHU	Push A, B, CC, DP, D, X, Y, S, or PC onto user stack
PULS	Pop A, B, CC, DP, D, X, Y, U, or PC from hardware stack
PULL	Pop A, B, CC, DP, D, X, Y, S, or PC from hardware stack
STS, STU	Store stack pointer to memory
STX, STY	Store index register to memory
TFR R1, R2	Transfer D, X, Y, S, or PC to D, X, Y, S, U, or PC
ABX	Add B accumulator to X (unsigned)

TABLE 7 — BRANCH INSTRUCTIONS

Instruction	Description
SIMPLE BRANCHES	
BEQ, LBEQ	Branch if equal
BNE, LBNE	Branch if not equal
BMI, LBMI	Branch if minus
BPI, LBPL	Branch if plus
BCS, LBCS	Branch if carry set
BCC, LBCC	Branch if carry clear
BVS, LBVS	Branch if overflow set
BVC, LBVC	Branch if overflow clear
SIGNED BRANCHES	
BGT, LBGT	Branch if greater (signed)
BVS, LBVS	Branch if valid 2's complement result
BGE, LBGE	Branch if greater than or equal (signed)
BEQ, LBEQ	Branch if equal
BNE, LBNE	Branch if not equal
BLE, LBLE	Branch if less than or equal (signed)
BVC, LBVC	Branch if valid 2's complement result
BLT, LBLT	Branch if less than (signed)
UNSIGNED BRANCHES	
BHI, LBHI	Branch if higher (unsigned)
BCC, LBCC	Branch if higher or same (unsigned)
BHS, LBHS	Branch if higher or same (unsigned)
BEQ, LBEQ	Branch if equal
BNE, LBNE	Branch if not equal
BLS, LBLS	Branch if lower or same (unsigned)
BCS, LBCS	Branch if lower (unsigned)
BLO, LBLO	Branch if lower (unsigned)
OTHER BRANCHES	
BSR, LBSR	Branch to subroutine
BRA, LBRA	Branch always
BRN, LBRN	Branch never

TABLE 8 — MISCELLANEOUS INSTRUCTIONS

Instruction	Description
ANDCC	AND condition code register
CWAI	AND condition code register, then wait for interrupt
NOP	No operation
ORCC	OR condition code register
JMP	Jump
JSR	Jump to subroutine
RTI	Return from interrupt
RTS	Return from subroutine
SWI, SWI2, SWI3	Software interrupt (absolute indirect)
SYNC	Synchronize with interrupt line

TABLE 9 — HEXADECIMAL VALUES OF MACHINE CODES

OP	Mnem	Mode	~	#	OP	Mnem	Mode	~	#	OP	Mnem	Mode	~	#
00	NEG	Direct	6	2	30	LEAX	Indexed	4+	2+	60	NEG	Indexed	6+	2+
01	*	↑	6	2	31	LEAY	↑	4+	2+	61	*	↑	6+	2+
02	*				32	LEAS	↓	4+	2+	62	*			
03	COM				33	LEAU	Indexed	4+	2+	63	COM			
04	LSR				34	PSHS	Immed	5+	2	64	LSR			
05	*				35	PULS	Immed	5+	2	65	*			
06	ROR	↓	6	2	36	PSHU	Immed	5+	2	66	ROR	↓	6+	2+
07	ASR				37	PULU	Immed	5+	2	67	ASR			
08	ASL, LSL				38	*	Inherent	3	1	68	ASL, LSL			
09	ROL				39	RTS				69	ROL			
0A	DEC				3A	ABX				6A	DEC			
0B	*	↓	6	2	3B	RTI				6B	*	↓	6+	2+
0C	INC				3C	CWAI	Inherent	6/15	1	6C	INC			
0D	TST				3D	MUL				6D	TST			
0E	JMP				3E	*				6E	JMP			
0F	CLR				3F	SWI				6F	CLR			
10	Page 2	—	—	—	40	NEGA	Inherent	2	1	70	NEG	↑	7	3
11	Page 3	—	—	—	41	*	↑	2	1	71	*			
12	NOP	Inherent	2	1	42	*				72	*			
13	SYNC	Inherent	≥ 4	1	43	COMA				73	COM			
14	*	Relative	5	3	44	LSRA				74	LSR			
15	*				45	*				75	*			
16	LBRA				46	RORA				76	ROR			
17	LBSR				47	ASRA				77	ASR			
18	*				48	ASLA, LSLA				78	ASL, LSL			
19	DAA	Inherent	2	1	49	ROLA	↓	2	1	79	ROL	↓	7	3
1A	ORCC	Immed	3	2	4A	DECA				7A	DEC			
1B	*	—	—	—	4B	*				7B	*			
1C	ANDCC	Immed	3	2	4C	INCA				7C	INC			
1D	SEX	Inherent	2	1	4D	TSTA				7D	TST			
1E	EXG	Immed	8	2	4E	*	Inherent	2	1	7E	JMP	↓	7	3
1F	TFR	Immed	6	2	4F	CLRA				7F	CLR			
20	BRA	↑	3	2	50	NEGB				80	SUBA	↑	2	2
21	BRN				51	*				81	CMBA			
22	BHI				52	*				82	SBCA			
23	BLS				53	COMB				83	SUBD			
24	BHS, BCC				54	LSRB				84	ANDA			
25	BLO, BCS	↓	3	2	55	*	↓	2	1	85	BITA	↓	2	2
26	BNE				56	RORB				86	LDA			
27	BEQ				57	ASRB				87	*			
28	BVC				58	ASLB, LSLB				88	EOBA			
29	BVS				59	ROLB				89	ADCA			
2A	BPL	↑	3	2	5A	DECB	Inherent	2	1	8A	ORA	↓	2	2
2B	BMI				5B	*				8B	ADDA			
2C	BGE				5C	INCB				8C	CMPX			
2D	BLT				5D	TSTB				8D	BSR			
2E	BGT				5E	*				8E	LDX			
2F	BLE	Relative	3	2	5F	CLRB				8F	*			



LEGEND

- ~ Number of MPU cycles (less possible push pull or indexed mode cycles)
- # Number of program bytes
- *
- Denotes unused opcode

TABLE 9 - HEXADECEMAL VALUES OF MACHINE CODES (CONTINUED)

OP	Mnem	Mode	n	r	OP	Mnem	Mode	n	r	OP	Mnem	Mode	n	r
80	SUBA	Direct	4	2	E0	SUBB	Direct	4	2	Page 2 and 3 Machine Codes				
81	CMPS	Direct	4	2	E1	CMPS	Direct	4	2					
82	SBCA	Direct	4	2	E2	SBCB	Direct	4	2	1021	LBRA	Relative	5	4
83	SBCD	Direct	4	2	E3	SBCB	Direct	4	2	1022	LBH	Relative	5	4
84	ANDA	Direct	4	2	E4	ADDD	Direct	4	2	1023	LBLS	Relative	5	4
85	BITA	Direct	4	2	E5	ANDB	Direct	4	2	1024	LBHS	Relative	5	4
86	LDA	Direct	4	2	E6	BTR	Direct	4	2	1025	LBUS	Relative	5	4
87	STA	Direct	4	2	E7	LDB	Direct	4	2	1026	LBNE	Relative	5	4
88	EORA	Direct	4	2	E8	ECR	Direct	4	2	1027	LBEO	Relative	5	4
89	ADCA	Direct	4	2	E9	ADCB	Direct	4	2	1028	LBVL	Relative	5	4
9A	ORA	Direct	4	2	EA	ORR	Direct	4	2	1029	LBVS	Relative	5	4
9B	ADDA	Direct	4	2	EB	ADDOB	Direct	4	2	102A	LBPI	Relative	5	4
9C	CMPS	Direct	4	2	EC	LDD	Direct	4	2	102B	LBPI	Relative	5	4
9D	JSR	Direct	4	2	ED	STO	Direct	4	2	102C	LBPI	Relative	5	4
9E	LDX	Direct	4	2	EE	LDD	Direct	4	2	102D	LBPI	Relative	5	4
9F	STX	Direct	4	2	EF	STL	Direct	4	2	102E	LBPI	Relative	5	4
AA	SUBA	Extended	5	2	F0	SUBB	Extended	5	2	102F	LBPI	Relative	5	4
AB	CMPS	Extended	5	2	F1	CMPS	Extended	5	2	1030	LBPI	Relative	5	4
AC	SBCA	Extended	5	2	F2	SBCB	Extended	5	2	1031	LBPI	Relative	5	4
AD	SBCD	Extended	5	2	F3	SBCB	Extended	5	2	1032	LBPI	Relative	5	4
AE	ANDA	Extended	5	2	F4	ADDD	Extended	5	2	1033	LBPI	Relative	5	4
AF	BITA	Extended	5	2	F5	ANDB	Extended	5	2	1034	LBPI	Relative	5	4
B0	LDA	Extended	5	2	F6	BTR	Extended	5	2	1035	LBPI	Relative	5	4
B1	STA	Extended	5	2	F7	LDB	Extended	5	2	1036	LBPI	Relative	5	4
B2	EORA	Extended	5	2	F8	STB	Extended	5	2	1037	LBPI	Relative	5	4
B3	ECRA	Extended	5	2	F9	ECR	Extended	5	2	1038	LBPI	Relative	5	4
B4	ADCA	Extended	5	2	FA	ADCB	Extended	5	2	1039	LBPI	Relative	5	4
B5	ORA	Extended	5	2	FB	ORR	Extended	5	2	103A	LBPI	Relative	5	4
B6	ADDA	Extended	5	2	FC	ADDOB	Extended	5	2	103B	LBPI	Relative	5	4
B7	CMPS	Extended	5	2	FD	LDD	Extended	5	2	103C	LBPI	Relative	5	4
B8	JSR	Extended	5	2	FE	STO	Extended	5	2	103D	LBPI	Relative	5	4
B9	LDX	Extended	5	2	FF	STL	Extended	5	2	103E	LBPI	Relative	5	4
BA	STX	Extended	5	2						103F	LBPI	Relative	5	4
NOTE: All unused opcodes are both unimplemented and illegal.														

FIGURE 19 — PROGRAMMING AID

Instruction	Forms	Addressing Modes												Description	5 H	3 N	2 Z	1 V	0 C						
		Immediate			Direct			Indexed			Extended									Inherent					
		Op	~	#	Op	~	#	Op	~	#	Op	~	#							Op	~	#			
ABX														3A	3	1				B ← X ← X (Unsigned)	•	•	•	•	•
ADC	ADCA ADCB	89 C9	2	2	99 D9	4	2	A9 E9	4	2	B9 F9	5	3							A ← M + C ← A B ← M + C ← B	•	•	•	•	•
ADD	ADDA ADDB ADDD	8B CB C3	2	2	9B DB D3	4	2	AB EB E3	4	2	B8 F8 F3	5	3							A ← M + A B ← M + B D ← M + M + 1 ← D	•	•	•	•	•
AND	ANDA ANDB ANDCC	94 C4 1C	2	2	94 D4 1C	4	2	A4 E4 1C	4	2	B4 F4 1C	5	3							A ← M & A B ← M & B CC ← IMM ← CC	•	•	•	•	•
ASL	ASLA ASLB													48 58	2	1					•	•	•	•	•
ASR	ASRA ASRB ASR													47 57	2	1					•	•	•	•	•
BFI	BFTA BFTB	B5 C5	2	2	95 D5	4	2	A5 E5	4	2	B5 F5	5	3							B ← Test A ← M ← A B ← Test B ← M ← B	•	•	•	•	•
CLR	CLRA CLRB CLR													4F 5F	2	1				C ← A C ← B C ← M	•	•	•	•	•
CMF	CMFA CMPB CMPD	81 C1 11	2	2	91 D1 11	4	2	A1 E1 11	4	2	B1 F1 11	5	3							C ← Compare M from A C ← Compare M from B C ← Compare M ← M + 1 from D	•	•	•	•	•
	CMPS	84 C4	2	2	94 D4	4	2	A4 E4	4	2	B4 F4	5	3							C ← Compare M ← M + 1 from S	•	•	•	•	•
	CMPL	81 C1	2	2	91 D1	4	2	A1 E1	4	2	B1 F1	5	3							C ← Compare M ← M + 1 from L	•	•	•	•	•
	CMPL	84 C4	2	2	94 D4	4	2	A4 E4	4	2	B4 F4	5	3							C ← Compare M ← M + 1 from X C ← Compare M ← M + 1 from Y	•	•	•	•	•
COM	COMA COMB COM													47 57	2	1				B ← A B ← B B ← M	•	•	•	•	•
CWAI		9C	2	2																CC ← IMM ← CC Wait for interrupt	•	•	•	•	•
DAA														79	2	1				Decimal Adjust A	•	•	•	•	•
DEC	DECA DECB DEC													4A 5A	2	1				A ← A - 1 B ← B - 1 M ← M - 1	•	•	•	•	•
FOR	FORA FORB	88 C8	2	2	98 D8	4	2	A8 E8	4	2	B8 F8	5	3							A ← M ← A B ← M ← B	•	•	•	•	•
EXG	RT ₁ RT ₂	1E	2	2																R1 ↔ R2	•	•	•	•	•
INC	INCA INCR INL													4C 5C	2	1				A ← A + 1 B ← B + 1 M ← M + 1	•	•	•	•	•
JMP																				R1 ← R2	•	•	•	•	•
JSR																				Jump to Subroutine	•	•	•	•	•
LD	LDA LDB LDD LDS	86 C6 D6 16	2	2	96 D6 D6 16	4	2	A6 E6 F6 16	4	2	B6 F6 16 16	5	3							M ← A M ← B M ← M + 1 ← D M ← M + 1 ← S	•	•	•	•	•
	LDC	CE	3	3	DE	5	2	EE	5	2	FE	6	3							M ← M + 1 ← X	•	•	•	•	•
	LDC	CE	3	3	DE	5	2	EE	5	2	FE	6	3							M ← M + 1 ← Y	•	•	•	•	•
	LDD	8E	3	3	9E	5	2	AE	5	2	BE	6	3							M ← M + 1 ← X	•	•	•	•	•
	LDD	8E	3	3	9E	5	2	AE	5	2	BE	6	3							M ← M + 1 ← Y	•	•	•	•	•
	LDD	10	4	4	10	6	3	1C	6	3	1C	7	4							M ← M + 1 ← Y	•	•	•	•	•
LEA	LEAS LEAU LEAX LEAY																			EA ← S EA ← U EA ← X EA ← Y	•	•	•	•	•

LEGEND

OP Operation Code (Hexadecimal)

~ Number of MPU Cycles

Number of Program Bytes

+ Arithmetic Plus

- Arithmetic Minus

• Multiply

M Complement of M

→ Transfer Into

H Half-carry (from bit 3)

N Negative (sign bit)

Z Zero result

V Overflow, 2's complement

C Carry from ALU

! Test and set if true, cleared otherwise

• Not Affected

CC Condition Code Register

: Concatenation

V Logical or

A Logical and

⊕ Logical Exclusive or

FIGURE 19 — PROGRAMMING AID (CONTINUED)

Instruction	Forms	Addressing Modes												Description	5 H	3 N	2 Z	1 V	0 C			
		Immediate			Direct			Indexed ¹			Extended									Inherent		
		Op	~	#	Op	~	#	Op	~	#	Op	~	#							Op	~	#
LSL	LSLA LSLB LSL				08	6	2	6H	6+	2+	8	7	3	48 68	2							
LSR	LSRA LSRB LSR				04	6	2	64	6+	2+	8	7	3	44 64	2							
MUL														30	11							
NEG	NEGA NEGB NEG				0C	6	2	6C	6+	2+	8	7	3	4C	11							
NOP														12	11							
OR	ORA ORB ORCC	8A CA 1A	2 2 3	2 2 2	9A DA 4	4 4 4	2 2 2	8A 8A 8A	4+	2+	8A 8A 8A	4+	2+	8A 8A 8A	4+	2+						
PSH	PSHS PSHL	34 36	5 6	4 4																		
PUL	PULS PULL	35 37	5 6	4 4																		
ROL	ROLA ROLB ROL				09	6	2	69	6+	2+	8	7	3	49	11							
ROR	RORA RORB ROR				06	6	2	96	6+	2+	8	7	3	46	11							
RTI														05	11							
RTS														09	11							
SBC	SBCA SBCB	82 C2	2 2	2 2	92 D2	4 4	2 2	82 82	4+	2+	8A 8A	4+	2+	8A 8A	4+	2+						
SEX														10	11							
ST	STA STB STD STS				97 D7 D0 D7	4 4 5 5	2 2 2 2	87 87 87 87	4+	2+	8A 8A 8A 8A	4+	2+	8A 8A 8A 8A	4+	2+						
	STL STX STY				8F 9F 9F	5 5 5	2 2 2	8F 8F 8F	4+	2+	8A 8A 8A	4+	2+	8A 8A 8A	4+	2+						
SUB	SUBA SUBB SUBD	80 C0 83	2 2 4	2 2 3	90 D0 93	4 4 5	2 2 2	80 80 80	4+	2+	8A 8A 8A	4+	2+	8A 8A 8A	4+	2+						
SWI	SWI ⁶ SWI ⁷ SWID													3F 3F 3F	19 20 20							
SYNC														13	≥ 4							
TFR	R1, R2	1F	6	2																		
TST	TSTA TSTB TST				00	6	2	6D 6+	6+	2+	7D 7	7	3	4D 5D	2 2							

NOTES:

- This column gives a base cycle and byte count. To obtain total count, add the values obtained from the INDEXED ADDRESSING MODE table.
- R1 and R2 may be any pair of 8 bit or any pair of 16 bit registers.
The 8 bit registers are: A, B, CC, DP.
The 16 bit registers are: X, Y, U, S, D, PC.
- EA is the effective address.
- The PSH and PUL instructions require 5 cycles plus 1 cycle for each **byte** pushed or pulled.
- 5(6) means: 5 cycles if branch not taken, 6 cycles if taken (Branch instructions).
- SWI sets I and F bits. SWI2 and SWI3 do not affect I and F.
- Conditions Codes set as a direct result of the instruction.
- Value of half-carry flag is undefined.
- Special Case — Carry set if b7 is SET.

FIGURE 19 — PROGRAMMING AID (CONTINUED)

Branch instructions

Instruction	Forms	Addressing Mode				H	N	Z	V	C
		OP	~	#	Description					
BCC	BCC	24	3	2	Branch if Carry	•	•	•	•	•
	LBCC	10	5/6	4	Long Branch if Carry	•	•	•	•	•
BCS	BCS	25	3	2	Branch if Carry Set	•	•	•	•	•
	LBCS	10	5/6	4	Long Branch if Carry Set	•	•	•	•	•
BEQ	BEQ	27	3	2	Branch if Equal	•	•	•	•	•
	LBEQ	10	5/6	4	Long Branch if Equal	•	•	•	•	•
BGE	BGE	2C	3	2	Branch if Greater or Equal	•	•	•	•	•
	LBGE	10	5/6	4	Long Branch if Greater or Equal	•	•	•	•	•
BGT	BGT	2E	3	2	Branch if Greater Than	•	•	•	•	•
	LBGT	10	5/6	4	Long Branch if Greater Than	•	•	•	•	•
BHI	BHI	22	3	2	Branch if Higher	•	•	•	•	•
	LBHI	10	5/6	4	Long Branch if Higher	•	•	•	•	•
BHS	BHS	24	3	2	Branch if Higher or Same	•	•	•	•	•
	LBHS	10	5/6	4	Long Branch if Higher or Same	•	•	•	•	•
BLE	BLE	2A	3	2	Branch if Less or Equal	•	•	•	•	•
	LBLE	10	5/6	4	Long Branch if Less or Equal	•	•	•	•	•
BLT	BLT	26	3	2	Branch if Less Than	•	•	•	•	•
	BLT	10	5/6	4	Long Branch if Less Than	•	•	•	•	•

Instruction	Forms	Addressing Mode				H	N	Z	V	C
		OP	~	#	Description					
BLS	BLS	23	3	2	Branch if Lower or Same	•	•	•	•	•
	LBLS	10	5/6	4	Long Branch if Lower or Same	•	•	•	•	•
BLT	B.LT	2D	3	2	Branch if Less Than	•	•	•	•	•
	LB.LT	10	5/6	4	Long Branch if Less Than	•	•	•	•	•
BMI	BMI	2B	3	2	Branch if Minus	•	•	•	•	•
	LBMI	10	5/6	4	Long Branch if Minus	•	•	•	•	•
BNE	BNE	26	3	2	Branch if Not Equal	•	•	•	•	•
	LBNE	10	5/6	4	Long Branch if Not Equal	•	•	•	•	•
BPL	BPL	2A	3	2	Branch if Plus	•	•	•	•	•
	LBPL	10	5/6	4	Long Branch if Plus	•	•	•	•	•
BRA	BRA	20	3	2	Branch Always	•	•	•	•	•
	LBRA	10	5/6	4	Long Branch Always	•	•	•	•	•
BRN	BRN	22	3	2	Branch if Never	•	•	•	•	•
	LB.RN	10	5/6	4	Long Branch if Never	•	•	•	•	•
BSR	BSR	28	3	2	Branch to Subroutine	•	•	•	•	•
	LB.SR	10	5/6	4	Long Branch to Subroutine	•	•	•	•	•
BVC	BVC	24	3	2	Branch if Carry Clear	•	•	•	•	•
	LBVC	10	5/6	4	Long Branch if Carry Clear	•	•	•	•	•
BVS	BVS	26	3	2	Branch if Carry Set	•	•	•	•	•
	LBVS	10	5/6	4	Long Branch if Carry Set	•	•	•	•	•

SIMPLE BRANCHES

	OP	~	#
BRA	20	3	2
LBRA	16	5	3
BRN	21	3	2
LBRN	1021	5	4
BSR	8D	7	2
LBSR	17	9	3

SIMPLE CONDITIONAL BRANCHES (Notes 1-4)

Test	True	OP	False	OP
N = 1	BMI	2B	BPL	2A
Z = 1	BEQ	27	BNE	26
V = 1	BVS	29	BVC	28
C = 1	BCS	25	BCC	24

SIGNED CONDITIONAL BRANCHES (Notes 1-4)

Test	True	OP	False	OP
r > m	BGT	2E	BLE	2F
r ≥ m	BGE	2C	BLT	2D
r = m	BEQ	27	BNE	26
r ≤ m	BLE	2F	BGT	2E
r < m	BLT	2D	BGE	2C

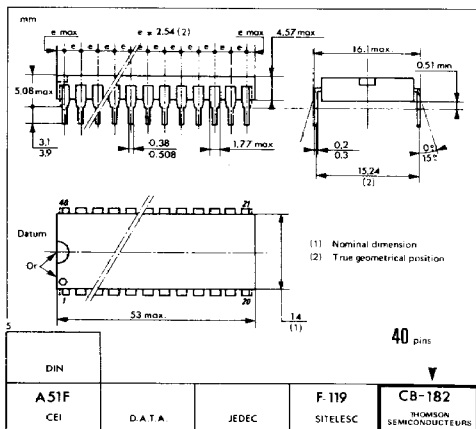
UNSIGNED CONDITIONAL BRANCHES (Notes 1-4)

Test	True	OP	False	OP
r > m	BHI	22	BLS	23
r ≥ m	BHS	24	BLO	25
r = m	BEQ	27	BNE	26
r ≤ m	BLS	23	BHI	22
r < m	BLO	25	BHS	24

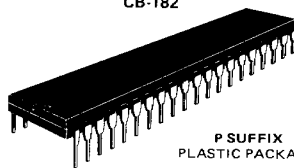
NOTES

- 1 All conditional branches have both short and long variations.
- 2 All short branches are two bytes and require three cycles.
- 3 All conditional long branches are formed by prefixing the short branch opcode with \$10 and using a 16-bit destination offset.
- 4 All conditional long branches require four bytes and six cycles if the branch is taken or five cycles if the branch is not taken.

CASE



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P SUFFIX
PLASTIC PACKAGE

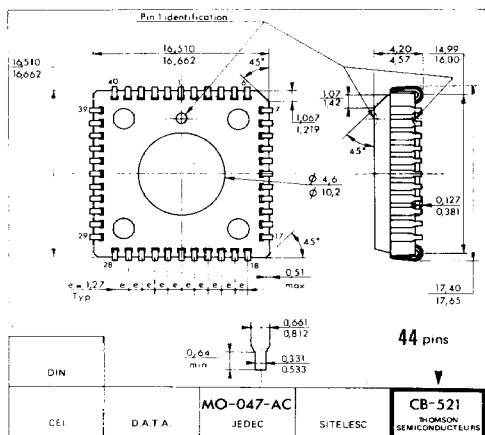
ALSO AVAILABLE

J SUFFIX
CERDIP PACKAGEC SUFFIX
CERAMIC PACKAGE

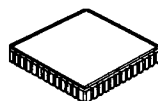
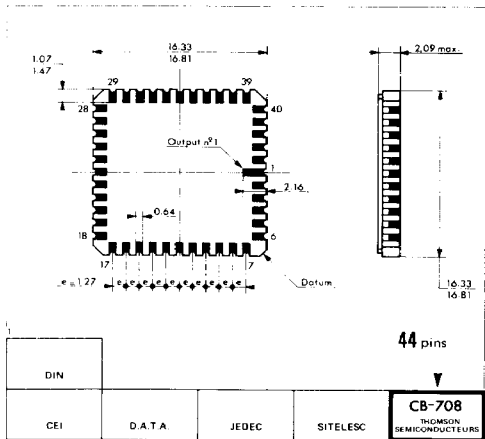
ORDERING INFORMATION

<div>EF68A09</div> <div>C</div> <div>M</div> <div>B/B</div> <div>Device</div> <div>Package</div> <div>Screening level</div> <div>Oper. temp.</div>												
The table below horizontally shows all available suffix combinations for package, operating temperature and screening level. Other possibilities on request.												
DEVICE	PACKAGE					OPER. TEMP			SCREENING LEVEL			
	C	J	P	E	FN	L*	V	M	Std	D	G/B	B/B
EF6809 (1.0 MHz)	•	•	•		•	•			•			
	•	•	•				•		•			
	•			•				•			•	•
EF68A09 (1.5 MHz)	•	•	•			•			•			
	•	•	•				•		•			
	•			•				•			•	•
EF68B09 (2.0 MHz)		•	•			•			•			
		•	•					•	•			
	•	•					•		•		•	
Examples : EF6809C, EF6809CV, EF6809CM												
Package : C : Ceramic DIL, J : Cerdip DIL, P : Plastic DIL, E : LCCC, FN : PLCC.												
Oper. temp. : L* : 0°C to +70°C, V : -40°C to +85°C, M : -55°C to +125°C, * : may be omitted.												
Screening level : Std : (no-end suffix), D : NFC 96883 level D,												
G/B : NFC 96883 level G, B/B : NFC 96883 level B and MIL-STD-883C level B.												

CASES

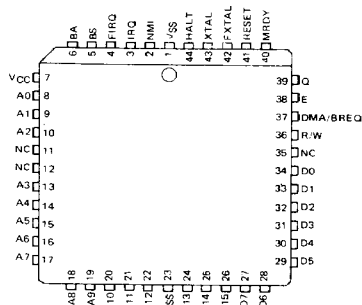


FN SUFFIX
PLCC 44



CB-708

E SUFFIX
LCCC 44



These specifications are subject to change without notice.
Please inquire with our sales offices about the availability of the different packages.

NOTES

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